

High Speed Capacitors



Advancing the possibilities with the breadth and depth of our industry leading smaller, lighter, extreme temperature stable filters, resonators, and ceramic components for military, space and commercial customers.



Company Overview

Dielectric Laboratories, Inc. (DLI) is your global partner for application specific microwave and millimeter wave components serving customers in fiber optic, wireless, medical, transportation, semiconductor, space, avionics and military markets. With over 35 years of experience, you can turn to DLI with confidence for your high frequency Single-Layer Capacitors, Multi-Layer Capacitors that are difficult to build and tight tolerance, Heat Sinks, Resonators, Filters, and Build-To-Print or Custom Thin Film Components.

DLI offers a broad range of Multi-Layer Capacitor products which are summarized in this catalog. Our products include C04, C06, C07, C08, C11, C17, C18, C22 and C40 High-Q Multi-Layer Capacitors. DLI has the world's most comprehensive array of Broadband Blocking Capacitors. We have the expertise in customizing, tight tolerances and meeting specific design targets. DLI continues to introduce exciting new innovations in custom ceramic resonator and filter technologies. These patent-protected products leverage decades of ceramic and Thin Film experience, creative and clever design expertise, and advanced prototyping and testing capabilities. Please discuss your needs with our Sales and Applications Engineering Team.

We are committed to serving you and thank you for your business.

RoHS Compliance Statement

DLI is a leading supplier to the electronic components market and is fully committed to offering products supporting Restriction of Hazardous Substances (RoHS) directive 2002/95/E. All of our Dielectric formulations are RoHS compliant and we offer a broad range of capacitors with RoHS compliant terminations. DLI complies with the requirements of the individual customer and will maintain product offerings that meet the demands of our industry.

Quality and Environmental Policy

DLI's reputation for quality and environmental responsibility is based on a commitment not only to meet our customers' requirements, but to exceed their expectations. The entire organization, beginning with top management, strives to achieve excellence in designing, manufacturing and delivering high Ω capacitors and proprietary thin film components for niche high frequency applications, while maintaining safe and healthy working conditions. Furthermore, DLI commits to achieve these goals in an environmentally responsible manner through our commitment to comply with environmental regulations and implement pollution prevention initiatives. DLI strives to continually improve the effectiveness of our Ω uality and Environmental Management System through the establishment and monitoring of objectives and targets.

AS9100 and ISO 9001 certified ISO 14001 certified





HIGH Q MULTI-LAYER AND BROADBAND BLOCKING CAPACITORS

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www.dilabs.com

"NA" Material temperature compensating capacitors.

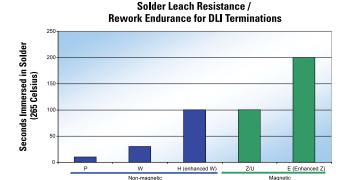
DLI is now offering our proprietary NA dielectric formulation in a variety of MLC case sizes. With its negative temperature coefficient of capacitance (N30+/-15ppm/ $^{\circ}$ C), this high-Q porcelain dielectric is ideal for temperature compensating situations.

NA is offered as a drop-in replacement for most AH/CF part numbers, please contact our sales representatives for details.

Temperature Coefficient of Capacitance

Extreme leach resistant terminations.

Engineering teams like to put our parts through their paces. When design engineers told us they'd like a termination that would allow them the freedom to use harsh solder profiles and multiple reworks, we listened! DLI has qualified enhanced versions of its RoHS compliant terminations designed to handle both the rigors of the test bench and the production floor with ease. The enhanced terminations are available in both standard (term code: E) and non-magnetic (term code: H) finishes. Please contact our sales team for more details.



Termination Style

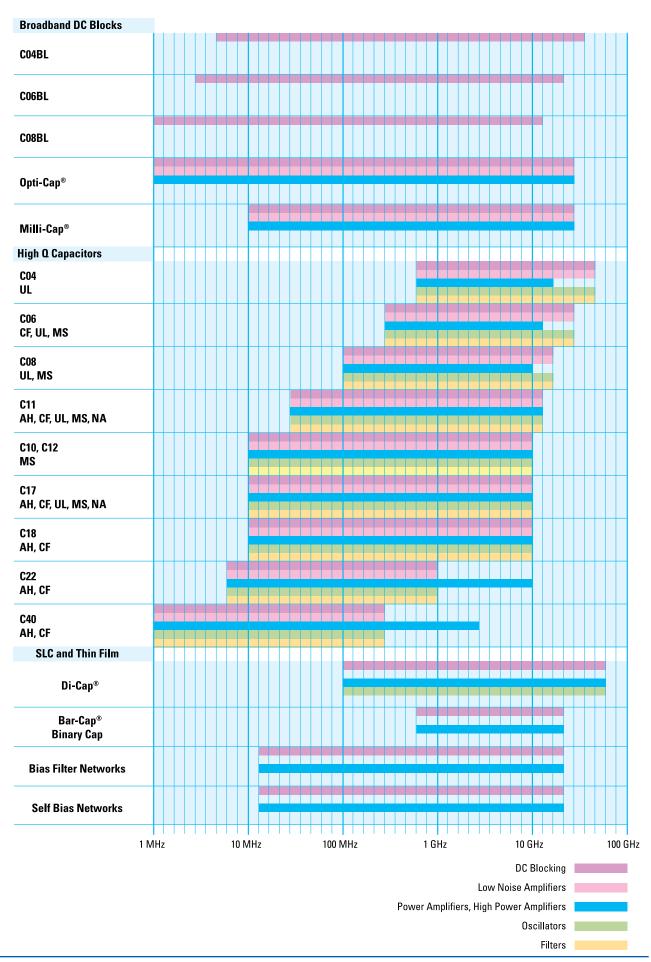
Tuning Rod Kits

DLI-designed tuning rods to utilize our C06, C11 or C17 capacitors of a specified value attached to our High-Q insulating holder to find the optimum capacitor for a particular circuit or application without soldering capacitors. Using a range of capacitance values around the nominal value will allow for quick selection of the appropriate capacitance and then the selection of the correct surface mount capacitor from DLI.



High Voltage 1111 case size.

DLI is please to introduce the new C18 series of enhanced voltage high-Q porcelain capacitors. With voltage ratings up to 2000V, the C18 is designed to be the most robust "1111" high-Q capacitor available today. The C18 is available in both our ultra stable (0±15ppm/°C) CF and temperature compensating (+90ppm/°C) AH dielectrics, and is form-factor compatible with our existing line of C17 "1111" capacitors. See pages 13 and 17 for more information!



Material & Case Size Summary Sheets

	DLI Series	Case Size Footprint	Cap Value Range	Cap (pF)		Typical ESR		Series Resonance	Working Voltage (WVDC)
		in. (mm)	(pF)		150 MHz	500 MHz	1 GHz	(MHz)	max
		.055 x .055		1	0.067	0.080	0.136	9200	
	C11AH		0.1 to 100	10	0.044	0.071	0.104	3000	250
		(1.40 x 1.40)		100	0.032	0.055	0.086	1000	
		.110 x .110		1	0.059	0.063	0.114	9064	
	C17AH	(2.79 x 2.79)	0.1 to 1000	10	0.039	0.060	0.085	3100	1000
		(2.79 X 2.79)		100	0.024	0.050	0.074	1290	
		110 110		10	0.059	0.094	0.138	3100	
AH	C18AH	.110 x .110	0.1 to 1000	100	0.028	0.069	0.109	1290	1000
		(2.79 x 2.79)		1000	0.023	0.063	-	400	
TCC (ppm/°C) (-55° to +125°C)				10	0.074	0.207	0.249	2480	
Porcelain (P90)	COOALI	.220 x .245		100	0.048	0.116	0.190	1000	2500
+90 ±20	C22AH	(5.84 x 6.35)	1 to 2700	1000	0.028	0.140	-	320	2300
				2700	0.027	-	_	214	
					10MHz	30MHz	100MHz		
				15	0.066	0.033	0.027	2100	
	C40AH	.380 x .380	1 to 5100	100	0.018	0.026	0.052	680	7200
		(9.65 x 9.65)		1000	0.009	0.017	0.033	210	
		(5.52.1.5.52)		5100	0.008	0.016	0.033	95	
									Working
	DLI Series	Case Size Footprint	Cap Value Range	Cap (pF)		Typical ESR		Series Resonance	Voltage (WVDC)
		in. (mm)	(pF)		150 MHz	500 MHz	1 GHz	(MHz)	max
		.063 x .030		1	0.182				
	00000					0.276	0.428	10300	
	C06CF		0.1 to 47	10	0.095	0.159	0.243	3200	250
	C06CF	.063 x .030 (1.60 x 0.80)	0.1 to 47	10 47	0.095 0.081	0.159 0.127	0.243 0.173	3200 1400	250
		(1.60 × 0.80)		10	0.095	0.159 0.127 0.089	0.243	3200 1400 9900	
	C06CF C11CF	(1.60 × 0.80) .055 × .055	0.1 to 47	10 47	0.095 0.081	0.159 0.127	0.243 0.173	3200 1400 9900 3100	250 250
		(1.60 × 0.80)		10 47 1	0.095 0.081 0.073	0.159 0.127 0.089	0.243 0.173 0.146	3200 1400 9900	
	C11CF	(1.60 × 0.80) .055 × .055 (1.40 × 1.40)		10 47 1 10	0.095 0.081 0.073 0.049	0.159 0.127 0.089 0.075	0.243 0.173 0.146 0.107	3200 1400 9900 3100	
		(1.60 x 0.80) .055 x .055 (1.40 x 1.40) .110 x .110		10 47 1 10 100	0.095 0.081 0.073 0.049 0.040	0.159 0.127 0.089 0.075 0.073	0.243 0.173 0.146 0.107 0.111	3200 1400 9900 3100 970	
	C11CF	(1.60 × 0.80) .055 × .055 (1.40 × 1.40)	0.1 to 100	10 47 1 10 100	0.095 0.081 0.073 0.049 0.040 0.073	0.159 0.127 0.089 0.075 0.073	0.243 0.173 0.146 0.107 0.111 0.124	3200 1400 9900 3100 970 9060	250
СF	C11CF	(1.60 x 0.80) .055 x .055 (1.40 x 1.40) .110 x .110	0.1 to 100	10 47 1 10 100 1	0.095 0.081 0.073 0.049 0.040 0.073 0.065	0.159 0.127 0.089 0.075 0.073 0.082 0.098	0.243 0.173 0.146 0.107 0.111 0.124 0.136	3200 1400 9900 3100 970 9060 3100	250
CF	C11CF C17CF	(1.60 × 0.80) .055 × .055 (1.40 × 1.40) .110 × .110 (2.79 × 2.79)	0.1 to 100	10 47 1 10 100 1 10 100	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041	0.159 0.127 0.089 0.075 0.073 0.082 0.098	0.243 0.173 0.146 0.107 0.111 0.124 0.136	3200 1400 9900 3100 970 9060 3100 1300	250
CF TCC (ppm/°C) (-55° to +125°C)	C11CF	.055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79)	0.1 to 100	10 47 1 10 100 1 10 100 100	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102	3200 1400 9900 3100 970 9060 3100 1300 400	250
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF	(1.60 × 0.80) .055 × .055 (1.40 × 1.40) .110 × .110 (2.79 × 2.79)	0.1 to 100 0.1 to 1000	10 47 1 10 100 1 10 100 1000	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158	3200 1400 9900 3100 970 9060 3100 1300 400	250 1000
TCC (ppm/°C) (-55° to +125°C)	C11CF C17CF	.055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79)	0.1 to 100 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118	3200 1400 9900 3100 970 9060 3100 400 9060 3100	250 1000
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF C18CF	.055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79)	0.1 to 1000 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1 10 150	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118	3200 1400 9900 3100 970 9060 3100 400 9060 3100 1000	250 1000 1000
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF	(1.60 × 0.80) .055 × .055 (1.40 × 1.40) .110 × .110 (2.79 × 2.79) .110 × .110 (2.79 × 2.79)	0.1 to 100 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1 10 150	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058 0.041 0.072	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087 0.068 0.113	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118 - 0.164	3200 1400 9900 3100 970 9060 3100 400 9060 3100 1000 2480	250 1000
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF C18CF	(1.60 x 0.80) .055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79) .110 x .110 (2.79 x 2.79)	0.1 to 1000 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1 10 150 10	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058 0.041 0.072 0.047	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087 0.068 0.113 0.079	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118 - 0.164 0.119	3200 1400 9900 3100 970 9060 3100 400 9060 3100 1000 2480 1000	250 1000 1000
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF C18CF	(1.60 x 0.80) .055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79) .110 x .110 (2.79 x 2.79)	0.1 to 1000 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1 10 10 100 100	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058 0.041 0.072 0.047 0.036	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087 0.068 0.113 0.079 0.067	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118 - 0.164 0.119 -	3200 1400 9900 3100 970 9060 3100 400 9060 3100 1000 2480 1000 320	250 1000 1000
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF C18CF	(1.60 x 0.80) .055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79) .110 x .110 (2.79 x 2.79)	0.1 to 1000 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1 10 10 100 100	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058 0.041 0.072 0.047 0.036 0.035	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087 0.068 0.113 0.079 0.067	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118 - 0.164 0.119 -	3200 1400 9900 3100 970 9060 3100 400 9060 3100 1000 2480 1000 320	250 1000 1000
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF C18CF	(1.60 x 0.80) .055 x .055 (1.40 x 1.40) .110 x .110 (2.79 x 2.79) .110 x .110 (2.79 x 2.79)	0.1 to 1000 0.1 to 1000	10 47 1 10 100 1 10 100 1000 1 10 150 10 1000 2700	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058 0.041 0.072 0.047 0.036 0.035	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087 0.068 0.113 0.079 0.067 - 30MHz	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118 - 0.164 0.119 - 100MHz	3200 1400 9900 3100 970 9060 3100 1300 400 9060 3100 1000 2480 1000 320 214	250 1000 1000 2500
TCC (ppm/°C) (-55° to +125°C) Porcelain (NP0)	C11CF C17CF C18CF	(1.60 × 0.80) .055 × .055 (1.40 × 1.40) .110 × .110 (2.79 × 2.79) .110 × .110 (2.79 × 2.79) .220 × .245 (5.84 × 6.35)	0.1 to 1000 0.1 to 1000 1 to 2700	10 47 1 10 100 1 100 1 100 1000 1 10 150 10 1000 2700	0.095 0.081 0.073 0.049 0.040 0.073 0.065 0.041 0.034 0.068 0.058 0.041 0.072 0.047 0.036 0.035 10MHz 0.121	0.159 0.127 0.089 0.075 0.073 0.082 0.098 0.070 0.073 0.086 0.087 0.068 0.113 0.079 0.067 - 30MHz 0.054	0.243 0.173 0.146 0.107 0.111 0.124 0.136 0.102 - 0.158 0.118 - 0.164 0.119 - 100MHz 0.037	3200 1400 9900 3100 970 9060 3100 400 9060 3100 1000 2480 1000 320 214	250 1000 1000

ESR and Resonance data is of typical performance and can vary from lot to lot.

	DLI Series	Case Size Footprint	Cap Value Range	Cap (pF)		Typical ESR		Series Resonance	Working Voltage (WVDC)
		in. (mm)	(pF)		150 MHz	500 MHz	1 GHz	(MHz)	max
		.040 x .020		1	0.081	0.095	0.148	9820	
	C04UL	(1.0 x 0.5)	0.1 to 10	5	0.038	0.057	0.088	3930	200
		(1.0 × 0.5)		10	0.036	0.058	0.087	2650	
		.063 x .030		5	0.052	0.072	0.107	1750	
	C06UL		0.1 to 47	15	0.028	0.041	0.064	1010	250
		(1.60 x 0.80)		47	0.023	0.043	0.070	570	
		440 070		5.6	0.053	0.086	0.129	5000	
	C07UL	.110 x .070	0.1 to 100	10	0.029	0.041	0.066	3960	250
OL		(2.79 x 1.72)		30	0.017	0.023	0.036	2540	
TCC (ppm/°C) (-55° to +125°C)				5.1	0.051	0.078	0.126	6000	
Ceramic (NP0)	C08UL	.080 x .050	0.1 to 100	9.5	0.041	0.060	0.094	4620	250
0 ±30		(2.0 x 1.27)		11	0.041	0.064	0.103	4340	
				2	0.066	0.084	0.125	7530	
	C11UL	.055 x .055	0.1 to 100	10	0.037	0.057	0.086	3800	250
		(1.40 x 1.40)		100	0.022	0.042	0.081	1430	
				10	0.040	0.056	0.082	2940	
	047111	.110 x .110		100	0.021	0.035	0.057	910	1000
	C17UL	(2.79 x 2.79)	0.1 to 1000	470	0.016	0.029	-	420	

	DLI Series	Case Size Footprint	Cap Value Range	Cap (pF)		Typical ESR		
		in. (mm)	(pF)	4 /	150 MHz	500 MHz	1 GHz	(MHz)
		000 000		1	0.090	0.135	0.207	10300
	C06MS	.063 x .030	0.3 to 100	10	0.058	0.099	0.140	3200
		(1.60 x 0.80)		100	0.040	0.073	0.104	1400
		000 050		1	0.200	0.140	0.190	10300
RAC	C08MS	.080 x .050	0.2 to 470	10	0.065	0.090	0.140	3200
MS		(2.0 x 1.27)		100	0.030	0.045	0.065	1400
TCC (ppm/°C)				1	0.160	0.110	0.120	9900
(-55° to +125°C) Ceramic (NP0)	C11MS	.055 x .055	0.2 to 220	10	0.060	0.090	0.120	3100
0 ±30	OTTIVIO	(1.40 x 1.40)		100	0.035	0.045	0.070	220
				10	0.642	0.097	0.110	3100
	C17MS	.110 x .110	0.3 to 2200	100	0.041	0.076	0.090	1300
	3171010	(2.79 x 2.79)	0.0 10 2200	1000	0.028	0.044	0.109	400
				2200	0.027	0.040	0.095	200

See page 21 for Working Voltage Rating (WVDC).

	DLI Series	Case Size Footprint in. (mm)	Cap Value Range (pF)	Cap (pF)	150 MHz	Typical ESR 500 MHz	1 GHz	Series Resonance (MHz)	Working Voltage (WVDC) max
		055 055		1	0.091	0.166	0.235	8796	
NΙΛ	C11NA	.055 x .055	0.1 to 100	10	0.064	0.117	0.166	2994	250
INA		(1.40 x 1.40)		100	0.046	0.083	0.117	1019	
TCC (ppm/°C)				1	0.047	0.086	0.121	10360	
(-55° to +125°C) Ceramic (NP0)	C17NΙΔ	C17NA .110 x .110 (2.79 x 2.79)	0.1 to 1000	10	0.033	0.061	0.085	3238	1000
N30 0 ±15	OTTIVA		0.1 to 1000	100	0.024	0.043	0.060	1012	1000
			1000	0.017	0.030	0.043	316		

Consult factory for additional case size data.

Multi-Layer Case Capacitance Tolerance Voltage Termination Test Level Code **Packaging** Capacitor Size Value Marking Code

Code

Case	Siza	1	۱7
Last	JIZE		

Case	Dimensions
04	0.040" x 0.020"
06	0.060" x 0.030"
07	0.110" x 0.070"
08	0.080" x 0.050"
10*	0.120" x 0.010"
11	0.055" x 0.055"
12*	0.120" x 0.060"
17	0.110" x 0.110"
18	0.110" x 0.110"
20*	0.220" x 0.200"
22	0.220" x 0.220"
36*	0.360" x 0.040"
40	0.380" x 0.380"

Voltage	9	7

Code	
5	50V
1	100V
8	150V
6	200V
9	250V
3	300V
4	500V
7	1000V
Α	1500V
G	2000V
В	2500V
D	3600V
F	5000V
Н	7200V
S	SPECIAL

Test Level X				
Code				
Χ	Commecial or Industrial			
Υ	Reduced Visual			
Α	MIL-PRF-55681 Group A			
C	MIL-PRF-55681 Group C			
D	Customer Specified			

Material U F			
Material	Characteristics		
АН	P90 High-Q		
CF	NPO High-Q		
MS	NPO High-Q		
UL	Ultra Low ESR-NP0		
BL	DC Blocking Ultra		
NA	N30 High-Q		

*	MS	Material	only

CF

apa
rst tv
hird d
xamp

Capacitance

Code

Capacitance	620
First two digits	Significant figures in capacitance
Third digit	Additional number of zeros
R	Represents a decimal point
Examples:	620 = 62pF
	152 = 1500pF

Tolerance

 $\pm 0.05 pF$

 $\pm 0.1 pF$

± 0.25pF

 $\pm 0.5 pF$ ± 1%

± 2%

± 5%

± 10%

± 20%

GMV

SPECIAL

Α

В

С

D

G

Κ

Μ

Χ

S

Termination

Code	Termination System	
Т	Ag Termination, Ni Barrier Layer, Heavy SnPb Plated Solder	
U	Ag Termination, Ni Barrier Layer, SnPb Plated Solder	
S	Ag Termination, Ni Barrier Layer, Gold Flash	RoHS
Z	Ag Termination, Ni Barrier Layer, Sn Plated Solder	RoHS
E	Ag Termination, Enhanced Ni Barrier, Sn Plated Solder	RoHS
P**	AgPd Termination	RoHS
Q	Polymer Termination, Ni Barrier Layer, Sn Plated Solder	RoHS
Υ	Polymer Termination, Ni Barrier Layer, SnPb Plated Solder	
M**	Polymer Termination, Cu Barrier Layer, Sn Plated Solder	RoHS
W**	Ag Termination, Cu Barrier Layer, Sn Plated Solder	RoHS
H**	Ag Termination, Enhanced Cu Barrier, Sn Plated Solder	RoHS
V**	Ag Termination, Cu Barrier Layer, SnPb Plated Solder	
R**	Ag Termination, Cu Barrier Layer, Heavy SnPb Plated Solder	

NOTE: All fields are required. Any specials, please consult factory.

Laser Mark

Code	Laser Marking
0	No marking
1	Single-side marked
2	Double-side marked
3*	Large single-side marked
4*	Large double-side marked
5	Vertical edge marked
9	Customer Specified

0

*Reduces DWV Rating.

Leading N				
Code	Lead Type			
Α	Axial Ribbon			
В	Radial Ribbon			
С	Center Ribbon			
D	Specialty Customer Defined			
Ε	Axial Wire			
F	Radial Wire			
N NONE				
NOTE: Consult Sales Representative for RoHS compliant leaded				

devices

Packaging

. aonaging		
Code	Packaging	
T	Tape & Reel – Horizontal	
V	Tape & Reel – Vertical	
W	Waffle Pack	
В	Bulk	
Р	Plastic Box	
R	Tube (Rail)	
S	Customer Specified	

<10pF A, B, C, D >10pF F, G, J, K, M

^{**} Nonmagnetic

DLI Multi-Layer Dielectric Materials

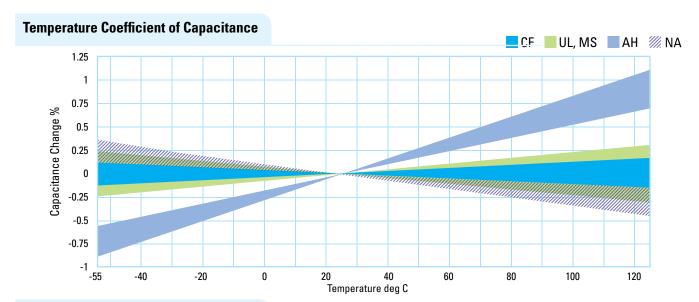
Dielectric Code	Temperature Coefficient -55°C to +125°C	Dissipation Factor @ 1 MHz	Insulation Resistance (M $oldsymbol{\Omega}$)		
Dielectric Code	(ppm/°C Maximum)	(% Maximum)	@ +25°C	@ +125°C	
АН	P90 ± 20	0.05	>106	>105	
CF	0 ± 15	0.05	>106	>105	
UL	0 ± 30	0.05	>105	>104	
MS	0 ± 30	0.05	>105	>104	
*BL	± 15%	2.50	>104	>10³	
NA	N30 ± 15	0.05	>106	>105	

All test conditions are per MIL-PRF-55681 revision A.

Dissipation Factor applies to values of 4.7pF or greater.

*Broadband Blocks only.

Other Dielectric formulations may be available, please contact your Sales Representative.



Termination Systems

Tornination dystems					
Code	Termination System	Application	Code	Termination System	Application
T	Ag Termination Ni Barrier Layer Heavy SnPb Plated Solder	High Reliability Applications Hand Soldering	Υ	Polymer Termination Ni Barrier Layer Sn Plated Solder	Resistant to Cracking High Reliability Applications High Volume & Hand Solder Assembly
U	Ag Termination Ni Barrier Layer SnPb Plated Solder	 High Reliability Applications High Volume & Hand Solder Assembly 	M RoHS	Polymer Termination Cu Barrier Layer	Resistant to Cracking Non-Magnetic Application High Volume & Hand Solder
S	Ag Termination Ni Barrier Layer	 Specialty Solder, Epoxy Applications 		Sn Plated Solder	Assembly
RoHS	Gold Flash	• Standard for 0402	W	Ag Termination Cu Barrier Layer	Non-Magnetic Application
Z	Ag Termination Ni Barrier Layer	• High Volume & Hand Solder	RoHS	Sn Plated Solder	High Volume
RoHS	Sn Plated Solder	Assembly	Н	Ag Termination Enhanced Cu Barrier	 Non-Magnetic Applications High Vol. & Hand Solder Assembly
Е	Ag Termination Enhanced Ni Barrier	 High Volume & Hand Solder Assembly 	RoHS	Sn Plated Solder	Ultra Leach Resistant
RoHS	Sn Plated Solder	Ultra Leach Resistant		Ag Termination	 Non-Magnetic Applications High Reliability Applications
P RoHS	AgPd Termination	Non-Magnetic Applications	V	Cu Barrier Layer SnPb Plated Solder	High Volume & Hand Solder Assembly
Q RoHS	Polymer Termination Ni Barrier Layer Sn Plated Solder	Resistant to CrackingHigh Volume & Hand Solder Assembly	R	Ag Termination Cu Barrier Layer Heavy SnPb Plated Solder	Non-Magnetic ApplicationsHigh Reliability ApplicationsHand Soldering

Lead Termination Codes

Axial Ribbon	Radial Ribbon	Center Ribbon	Axial Wire Lead	Radial Wire Lead
Code A	Code B	Code C	Code E	Code F
10				TE .

Leads are attached with high melting point solder (HMP) at 296°C.

Test Level Codes

Test code	Inspection Description (see individual part pages for additional detail)
Υ	100% IR, 1% AQL visual, 1% AQL Electrical (DWV, Cap., DF)
X	100% IR, 100 % visual, 1% AQL Electrical (DWV, Cap., DF)
Α	Group A testing per MIL – PRF – 55681
С	Group C testing per MIL – PRF – 55681
D	Customer Defined

Packaging Configurations

	C:	7" Reel, 8	8mm Tape	7" Reel, 16mm Tape	13" Reel, 16mm Tape		
Case Style	Size L x W	Horizontal Orientation	Vertical Orientation	Horizontal Orientation	Horizontal Orientation	2" x 2" Waffle Pack	
C04	0.040" x 0.020"	5000					
C06	0.060" x 0.030"	4000				108	
C07	0.110" x 0.070"	750					
C08	0.080" x 0.050"	5000	3100			108	
C11	0.055" x 0.055"	3500	3100			108	
C17	0.110" x 0.110"	2350	750			49	
C18	0.110" x 0.110"	2350	750			49	
C22	0.220" x 0.245"	500					
C40	0.380" x 0.380"	250		250	1300		

Typically a minimum 500 piece order for tape and reel packaging.

Standard Packaging: Bulk in plastic bags. Consult factory for custom packaging solutions.

Packaging Configurations for MS

0	C:	7" Reel, 8mm Tape	13" Reel, 16mm Tape		
Case Style	Size L x W	Horizontal Orientation	Vertical Orientation		
C04	0.040" x 0.020"	16,000	16,000		
C06	0.060" x 0.030"	4,000	16,000		
C08	0.080" x 0.050"	3,000	12,000		
C10	0.120" x 0.100"	2,000	8,000		
C11	0.055" x 0.055"	2,500	10,000		
C12	0 120" x 0 060"	2 500	10 000		

0	C:	7" Reel, 8mm Tape	13" Reel, 16mm Tape			
Case Style	Size L x W	Horizontal Orientation	Vertical Orientation			
C17	0.110" x 0.110"	1,000	4,000			
C18	0.180" x 0.120"	1,000	4,000			
C20	0.220" x 0.200"	1,000	4,000			
C22	0.220" x 0.245"	1,000	4,000			
C36	0.360" x 0.400"	-	500			

Minimum of one full reel.

 $Standard\ Packaging:\ Bulk\ in\ plastic\ bags.$

Consult factory for custom packaging solutions.

		Recor	nmended Pad Spac	ing Dimensions	(inches)					
Case Size	Internal		Reflow Soldering			Wave Soldering				
Gase Size	Electrode	Α	В	C	Α	В	С			
C04	Horizontal	0.076	0.036	0.010	0.106	0.036	0.020			
C04	Vertical		Not Recommended			Not Recommended				
C06	Horizontal	0.106	0.051	0.020	0.136	0.051	0.020			
C00	Vertical		Not Recommended			Not Recommended				
C07	Horizontal	0.119	0.141	0.020	0.149	0.141	0.020			
CO7	Vertical		Not Recommended			Not Recommended				
C08	Horizontal	0.127	0.071	0.020	0.157	0.071	0.020			
000	Vertical	0.127	0.064	0.020	0.157	0.064	0.020			
C11	Horizontal	0.114	0.084	0.020	0.144	0.084	0.020			
UII	Vertical	0.114	0.063	0.020	0.144	0.063	0.020			
C17	Horizontal	0.182	0.147	0.040	0.212	0.147	0.040			
617	Vertical	0.182	0.115	0.040	0.212	0.115	0.040			
C18	Horizontal	0.182	0.152	0.070	0.212	0.152	0.070			
CIO	Vertical	0.182	0.115	0.070	0.212	0.115	0.070			
C22	Horizontal	0.282	0.288	0.110	0.312	0.288	0.110			
022	Vertical	Not Recommended				Not Recommended				
C40	Horizontal	0.445	0.420	0.290	0.475	0.420	0.290			
U4U	Vertical		Not Recommended		Not Recommended					

	Case Size Definitions																	
			Width ⁽¹⁾			Length ⁽¹⁾			Thickness ⁽¹⁾		Gap Min		Band	Min ⁽²⁾	Band Max ⁽²⁾			
Case Size	Case Size EIA	Available Termination Style	Inc	Inches m		m Inches		hes	mm		(Max)		(Between Bands)		(Plated)		(Plated)	
		•	Min	Max	Min	Max	Min	Max	Min	Max	Inches	mm	Inches	mm	Inches	mm	Inches	mm
04BL	0402	US	0.014	0.026	0.362	0.667	0.034	0.046	0.869	1.173	0.025	0.640	0.008	0.193	0.004	0.097	0.017	0.427
04UL	0402	S	0.014	0.026	0.362	0.667	0.034	0.046	0.869	1.173	0.025	0.640	0.008	0.193	0.004	0.097	0.017	0.427
06BL	0603	USZ	0.023	0.038	0.579	0.960	0.051	0.069	1.303	1.760	0.032	0.800	0.010	0.241	0.007	0.169	0.027	0.680
06CF	0603	USZEPWHVR	0.023	0.038	0.579	0.960	0.051	0.069	1.303	1.760	0.032	0.800	0.010	0.241	0.007	0.169	0.027	0.680
06UL	0603	USZ	0.022	0.041	0.555	1.040	0.051	0.076	1.303	1.920	0.033	0.827	0.014	0.362	0.007	0.169	0.027	0.680
07UL	0711	SZ	0.090	0.131	2.292	3.334	0.052	0.089	1.327	2.267	0.105	2.667	0.019	0.483	0.008	0.193	0.047	1.200
08BL	0805	USZ	0.040	0.061	1.013	1.547	0.065	0.097	1.641	2.454	0.054	1.360	0.010	0.241	0.014	0.362	0.041	1.040
08UL	0805	USZ	0.040	0.061	1.013	1.547	0.065	0.097	1.641	2.454	0.054	1.360	0.010	0.241	0.014	0.362	0.041	1.040
11	0505	USZEPQYMWHVR	0.038	0.074	0.965	1.867	0.043	0.074	1.086	1.867	0.053	1.334	0.014	0.362	0.008	0.193	0.029	0.733
11	0505	Т	0.038	0.074	0.965	1.867	0.043	0.084	1.086	2.134	0.053	1.334	0.014	0.362	N/A	N/A	N/A	N/A
17	1111	USZEPQYMWHVR	0.090	0.131	2.292	3.334	0.095	0.137	2.413	3.467	0.105	2.667	0.038	0.965	0.008	0.193	0.047	1.200
17	1111	Т	0.090	0.137	2.292	3.467	0.095	0.152	2.413	3.867	0.105	2.667	0.038	0.965	N/A	N/A	N/A	N/A
18	1111 ⁽³⁾	UZEWHV	0.090	0.142	2.292	3.600	0.095	0.152	2.413	3.867	0.105	2.667	0.043	1.086	0.008	0.193	0.047	1.200
22	2222	U S Z E P Q Y M W H V R	0.223	0.278	5.671	7.068	0.200	0.252	5.067	6.401	0.137	3.467	0.124	3.137	N/A	N/A	N/A	N/A
40	3838	USZEPQYMW HVR	0.352	0.410	8.928	10.401	0.352	0.415	8.928	10.535	0.137	3.467	0.276	6.998	N/A	N/A	N/A	N/A

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⁽¹⁾ Dimensions listed include the termination. (2) Band widths are from corner to corner of part.

⁽³⁾ Enhanced voltage handling case size.

Chip Selection

Multilayer capacitors (MLC) are categorized by dielectric performance with temperature, or "temperature coefficient", as these devices vary in behavior over temperature. The choice of component is thus largely determined by the temperature stability required of the device, i.e. type of dielectric, and the size necessary for a given capacitance and voltage rating. The following items are pertinent to chip selection:

Dielectric Type

CF: Ultra stable Class I dielectric exceeds EIA COG requirements with negligible dependence of electrical properties on temperature, voltage, frequency and time, used in circuitry requiring very stable performance.

AH: EIA Class 1 dielectric with a dielectric constant that increases with temperature (90ppm/°C). Useful for temperature compensation where other board components may be losing capacitance with temperature.

NA: EIA Class 1 dielectric with a negative TCC. Useful in situations where other board components are gaining capacitance with temperature.

UL: EIA Stable Class 1 dielectric, with extremely low ESR. Useful in any application where heat generation or signal loss are concerns.

BL: EIA Stable Class II dielectric (X7R), with predictable change in properties with temperature, voltage, frequency and time. Used as blocking, de-coupling, bypassing and frequency discriminating elements. This dielectric is ferroelectric, and provides higher capacitance than Class 1.

MS: Stable Class 1 dielectric. Particularly suited to high capacitance or high volume applications.

Capacitor Size

Size selection is based primarily on capacitance value, voltage rating, and resonance frequency. Smaller units are generally less expensive; 0603 is the most economical size. Because mass affects the thermal shock behavior of chips, size selection must consider the soldering method used to attach the chip to the board. C18 and smaller can be wave, vapor phase or reflow soldered. Larger units require reflow soldering.

Termination Material

Nickel barrier termination, with exceptional solder leach resistance is recommended for all applications involving solder. DLI offers two versions of the nickel barrier termination. The "Z" termination is a nickel barrier with 100% matte tin for a lead free capacitor. The "U" termination is a nickel barrier with 90/10 tin/lead for military applications. Non-magnetic versions of these termination finishes are also available.

Solder Leaching

DLI's termination finishes are designed to withstand RoHS attachment methods. During soldering, time above 230°C should be minimized to reduce thinning of the barrier layer and subsequent bond failure. DLI offers enhanced magnetic and non-magnetic termination finishes for applications requiring extended soldering time or repeated reflow cycles. Please consult your Sales Representative when ordering.

Packaging

Units are available in bulk, reeled or in waffle pack.

Attachment Methods

Bonding of capacitors to substrates can be categorized into two methods, those involving solder, which are prevalent, and those using other materials, such as epoxies and thermo-compression or ultrasonic bonding with wire. Please see DLI application note "Recommended Solder Attachment Techniques for Multi-Layer Chip and Pre-Thinned Capacitors" located on out website, www.dilabs.com.

Soldering

Soldering methods commonly used in the industry and recommended are Reflow Soldering, Wave Soldering, and to a lesser extent, Vapor Phase Soldering. All these methods involve thermal cycling of the components and therefore the rate of heating and cooling must be controlled to preclude thermal shocking of the devices. In general, rates which do not exceed 120°C per minute and a temperature spike of 100°C maximum for any soldering process on sizes C18 and smaller is advisable. Other precautions include post soldering handling, primarily avoidance of rapid cooling with contact with heat sinks, such as conveyors or cleaning solutions.

Large chips are more prone to thermal shock as their greater bulk will result in sharper thermal gradients within the device during thermal cycling. Units larger than C18 experience excessive stress if processed through the fast cycles typical of solder wave or vapor phase operations. Solder reflow is most applicable to the larger chips as the rates of heating and cooling can be slowed within safe limits. In general, rates that do not exceed 60°C per minute and a temperature spike of 50°C maximum for any soldering process on sizes larger than C18 is advisable.

Attachment using a soldering iron requires extra care, particularly with large components, as thermal gradients are not easily controlled and may cause cracking of the chip. Precautions include preheating of the assembly to within 100°C of the solder flow temperature, the use of a fine tip iron which does not exceed 30 watts, and limitation of contact of the iron to the circuit pad areas only.

Bonding

Hybrid assembly using conductive epoxy or wire bonding requires the use of silver palladium or gold terminations. Nickel barrier termination is not practical in these applications, as intermetallics will form between the dissimilar metals. The ESR will increase over time and may eventually break contact when exposed to temperature cycling.

Cleaning

Chip capacitors can withstand common agents such as water, alcohol and degreaser solvents used for cleaning boards. Ascertain that no flux residues are left on the chip surfaces as these diminish electrical performance.

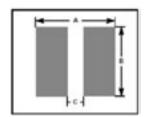
DLI Shelf Life

Capacitors are solderable for a maximum of one year from the date of shipment if properly stored in the original packaging. Dry nitrogen storage is preferable for longer periods.

Board Design Considerations

The amount of solder applied to the chip capacitor will influence the reliability of the device. Excessive solder can create thermal and tensile stresses on the component which could lead to fracturing of the chip or the solder joint itself. Insufficient or uneven solder application can result in weak bonds, rotation of the device off line or lifting of one terminal off the pad (tombstoning). The volume of solder is process and board pad size dependent. WAVE SOLDERING exposes the devices to a large solder volume, hence the pad size area must be restricted to accept an amount of solder which is not detrimental to the chip size utilized. Typically the pad width is 66% of the component width, and the length is .030" (.760 mm) longer than the termination band on the chip. An 0805 chip which is .050" wide and has a .020" termination band therefore requires a pad .033" wide by .050" in length. Opposing pads should be identical in size to preclude uneven solder fillets and mismatched surface tension forces which can misalign the device. It is preferred that the pad layout results in alignment of the long axis of the chips at right angles to the solder wave, to promote even wetting of all terminals. Orientation of components in line with the board travel direction may require dual waves with solder turbulence to preclude cold solder joints on the trailing terminals of the devices, as these are blocked from full exposure to the solder by the body of the capacitor. Restrictions in chip alignment do not apply to SOLDER REFLOW or VAPOR PHASE processes, where the solder volume is controlled by the solder paste deposition on the circuit pads There are practical limitations on capacitor sizes that prohibit reliable direct mounting of chip capacitors larger than 2225 to a substrate. Without mechanical restriction, thermally induced stresses are released once the capacitor attains a steady state condition, at any given temperature. Capacitors bonded to substrates, however, will retain some stress, due primarily to the mismatch of expansion of the component to the substrate; the residual stress on the chip is also influenced by the ductility and hence the ability of the bonding medium to relieve the stress. Unfortunately, the thermal expansions of chip capacitors differ significantly from those of substrate materials.

Recommended Printed Wire Board Land Patterns



Printed Wire Board land pattern design for chip components is critical to ensure a reliable solder fillet, and to reduce nuisance type manufacturing problems such as component swimming and tombstoning. The land pattern suggested can be used for reflow and wave solder operations as noted. Land patterns constructed with these dimensions will yield optimized solder fillet formation and thus reduce the possibility of early failure.1

A = (Max Length) + 0.030" (.762mm)*B = (Max Width) + 0.010" (.254mm)**

C = (Min Length) - 2 (Nominal Band)***

* Add 0.030" for Wave Solder operations.

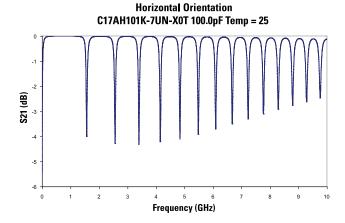
1. Frances Classon, James Root, Martin Marietta Orlando Aerospace, "Electronics Packaging and Interconnection Handbook".

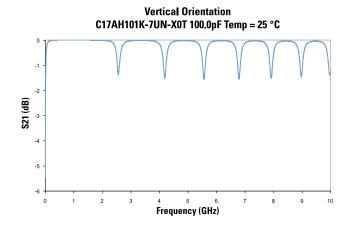
Temperature Precautions

The rate of heating and cooling must be controlled to preclude thermal cracking of ceramic capacitors. Soldering temperatures should not exceed 200°C per minute, temperature variation must not exceed 100°C maximum for any solder operation. Avoid forced cooling or contact with heat sinks, such as conveyor belts, metal tables or cleaning solutions, before the chips reach ambient temperatures.

MLC Orientation - Horizontal and Vertical Mounting

The orientation of the MLC relative to the ground plane affects the devices' impedance. When the internal electrodes are parallel to the ground plane (Horizontal mounting) the impedance of the MLC resembles a folded transmission line driven from one end. The below graph shows the modeled insertion loss and parallel resonances of C17AH101K-7UN-X0T with horizontal mounting. When the internal electrodes are perpendicular to the ground plane (Vertical mounting, bottom graph) the MLC impedance resembles a folded transmission line driven from the center reducing resonance effects. C11,17 are available with vertical or horizontal orientation in tape and reel packaging. Modeling can be done in CapCad. HP/EEs of series 4 contains models for C11 and C17 in the element libraries under Dielectric Laboratories MLC.





^{**} Replace "Max Width" with "Max Thickness" for vertical mounting.

*** "C" to be no less than 0.02", change "A" to (Max Length) + 0.020". For CO4 "C" to be no less than 0.01".

AH Series: P90 Porcelain Capacitors

Description Porcelain Capacitors Positive TC "P90" Low ESR, High Q Capacitance

Range 0.1 - 5100 pF High Self-resonance

Low Noise **Established Reliability**

Functional Applications

Impedance Matching DC Blocking **Bypass** Coupling Tuning & Feedback

Amplifier Matching Networks VCO Frequency Stabilization Filtering, Diplexers & Antenna Matching

High RF Power Circuits

Benefits

Oscillators Timing Circuits Filters **RF Power**

Amplifiers & Delay Lines Stable TC, -55° to +125°C Operating Range

SMD Compatibility

Lower ESR

Power Handling, High Voltage



Dielectric Material	Temperature Coefficient	Dissipation Factor	Dielectric With		Resistance inimum)	Aging	Piezoelectric Effects	Dielectric Absorption	
Code	(ppm/°C Maximum)	(% @ 1MHz Maximum)	Voltage Rating (Volts)	DWV (Volts)	@ +25°C	@ +125°C			
АН	+90 ± 20	0.05	Please see chart (pg. 13)	250% of WVDC for 5 sec unless specified in chart (pg. 13)	10 ⁶	10 ⁵	None	None	None

Part Number Breakdown*

Case Size

Multi

Layer

620

Material

System

Capacitance

Tolerance

Level

Voltage

Code

Termination Code

Test Level

0 Marking

Code

Packaging

Available Termination Types

C11	T, U, S, Z, E, P, Q, Y, M, W, H, V, R
C17	T, U, S, Z, E, P, Q, Y, M, W, H, V, R
C18	U, Z, E, Y, W, H
C22	U, S, Z, E, P, Q, Y, M, W, H, V, R
C40	T, U, S, Z, E, P, Q, Y, M, W, H, V, R

Code	Termination System
T	Ag Term, Ni Barrier Layer, Heavy SnPb Plated Solder
U	Ag Termination, Ni Barrier Layer, SnPb Plated Solder
S	Ag Termination, Ni Barrier Layer, Gold Flash, RoHS
Z	Ag Termination, Ni Barrier Layer, Sn Plated Solder, RoHS
E	Ag Termination, Enhanced Ni Barrier Sn Plated Solder, RoHS
Р	AgPd Termination, RoHS
Q	Polymer Termination, Ni Barrier Layer, Sn Plated Solder, RoHS
Υ	Polymer Termination, Ni Barrier Layer, SnPb Plated Solder,
M	Polymer Termination, Cu Barrier Layer, Sn Plated Solder, RoHS
W	Ag Termination, Cu Barrier Layer, Sn Plated Solder
Н	Ag Termination, Enhanced Cu Barrier Sn Plated Solder, RoHS
V	Ag Termination, Cu Barrier Layer, SnPb Plated Solder
R	Ag Termination, Cu Barrier Layer,

Heavy SnPb Plated Solder

Available Lead Types

C11 A, B, D C17 A, B, C, D, E, F C18 A, B, C, D, E, F C22 A, B, C, D, E, F C40 A, B, C, D, E, F

Special Leading requirements available.

Code	Lead Types
Α	Axial Ribbon
В	Radial Ribbon
С	Center Ribbon
D	Customer Specified
E	Axial Wire
F	Radial Wire
N	None

Test Level -All Case Sizes

Χ Standard Υ Reduced Visual MIL-PRF-55681 Α Group A C MIL-PRF-55681 Group C Customer Specified

Available Laser Marking

Leading

Code

C11 0, 1, 2, 5 C17 0, 1, 2, 3, 4, 5 C18 0, 1, 2, 5 C22 0, 1 C40 0, 1

Code Laser Marking No marking

1	Single-side marked
2	Double-side marked
3	Large single- side marked
4	Large double- side marked
5	Vertical edge marked
9	Customer Specified

Available Packaging

C11 T, V, W, B, P, S C17 T, V, W, B, P, S C18 T, V, W, B, P, S C22 T, B, P, S C40 T, B, P, S, R

Code Packaging

Τ

Tape & Reel –

Horizontal

V	Tape & Reel – Vertical
W	Waffle Pack
В	Bulk
Р	Plastic Box
R	Tube (Rail)
S	Customer Specified

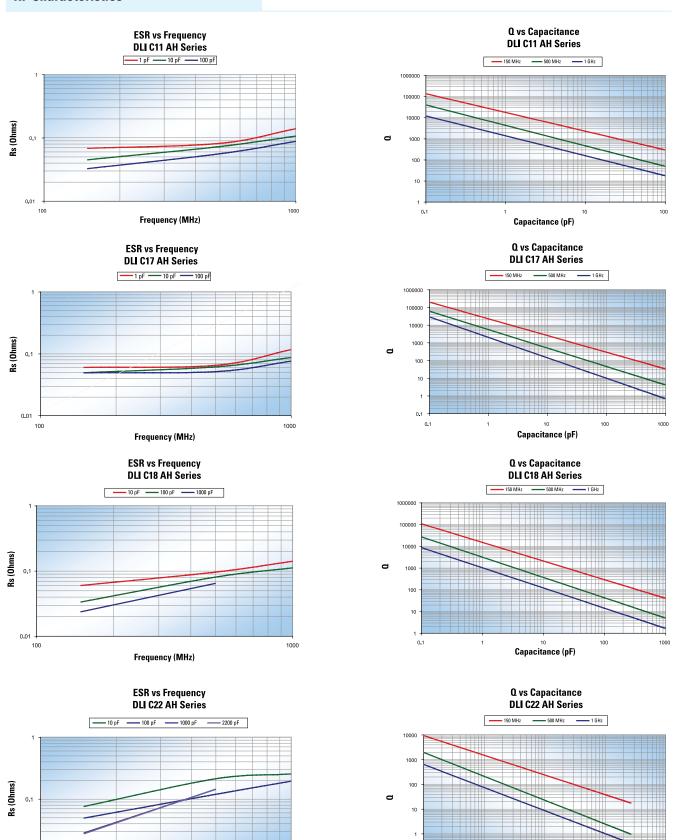
^{*}See page 6 for complete part number system.

Capacitance and Voltage Table

OR1	CAP (pF)	CASE SIZE C11 0505	CASE SIZE C17 1111	CASE SIZE C18 1111	CASE SIZE C22 2225	CASE SIZE C40 383
OR1 OR2 OR3 OR4 OR5 OR6 OR7 OR8 OR9 1R0 1R1 1R3 1R4 1R5 1R6 1R7 1R8 2R0 2R1 2R2 2R4 2R7 3R0 3R3 3R6 6R8 7R5 8R2 9R1 100 110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 6750 820 910 101	0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.3 1.4 1.5 1.6 1.7 1.8 1.9 2.0 2.1 2.2 2.4 2.7 3.0 3.3 3.6 3.9 4.3 4.7 5.1 5.6 6.2 6.8 7.5 8.2 9.1 10 11 12 13 15 16 18 20 22 24 27 30 33 36 39 43 47 51 16 18 20 22 24 27 30 33 36 39 43 47 51 56 62 68 75 82 9.1 100 11	250V Code 9 DWV = 625V 200V Code 6 DWV = 500V	1000V Code 7 DWV = 2500V	2000V Code G DWV = 2500V	2500V Code B DWV = 3000V	7200V Code H DWV = 8700V
111 121 131 151 161 181 201 221 241 271	110 120 130 150 160 180 200 220 240 270		500V Code 4 DWV = 1250V	1000V Code 7 DWV = 2500V		3600V Code D DWV = 4400V
301 331 361 391 431 471	300 330 360 390 430 470		200V Code 6 DWV = 500V	200V Code 6 DWV = 500V	1500V Code A DWV = 1800V	
511 561 621 681	510 560 620 680		100V Code 1 DWV = 250V	100V Code 1 DWV = 250V	1000V	2500V Code B DWV = 3750V
751 821 911 102 122	750 820 910 1000 1200		50V Code 5 DWV = 125V	50V Code 5 DWV = 125V	Code 7 DWV = 1500V	1000V Code 7
152 152 182 222 272	1500 1500 1800 2200 2700				500V Code 4, DWV = 1250V 300V Code 3	DWV = 1500V
332 392 472 512	3300 3900 4700 5100				0000	500V Code 4 DWV = 1250V
212			· ·	2350	500	250

13 www.dilabs.com

RF Characteristics



The information above represents typical device performance.

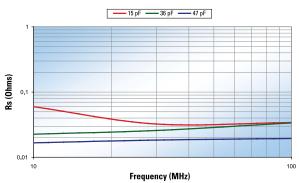
Frequency (MHz)

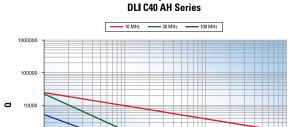
0.01

Capacitance (pF)

RF Characteristics

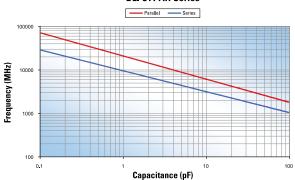


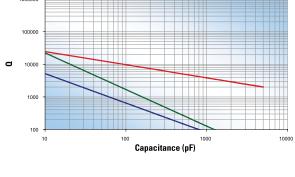




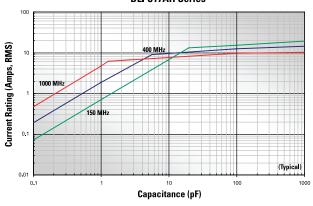
Q vs Capacitance

Resonant Frequency vs Capacitance DLI C11 AH Series

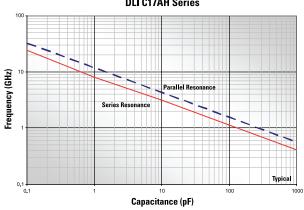




Current Rating vs. Capacitance, (infinite heat sink, 25°C ambient temperature) **DLI C17AH Series**



First Resonance Frequency vs Capacitance **DLI C17AH Series**



CF Series: Ultrastable Porcelain Capacitors

Description

Porcelain Capacitors Ultra Temperature Stable Low ESR, High Q Capacitance Range 0.1 - 5100 pF High Self-resonance Low Noise

Established Reliability

Functional Applications

Impedance Matching DC Blocking **Bypass** Coupling Tuning & Feedback **Amplifier Matching Networks** VCO Frequency Stabilization Filtering, Diplexers & Antenna Matching **High RF Power Circuits**

Benefits

Oscillators **Timing Circuits Filters** RF Power Amplifiers & **Delay Lines** Stable TC, -55° to +125°C **Operating Range** High Q SMD Compatibility Lower ESR Power Handling, High Voltage



Dielectric Characteristics

Dielectric Material	Temperature Coefficient (ppm/°C Maximum)	Coefficient	Dissipation Factor	Dielectric With	Insulation Resistance (M Ω Minimum)		Aging	Piezoelectric Effects	Dielectric Absorption
Code		(% @ 1MHz Maximum)	Voltage Rating (Volts)	DWV (Volts)	@ +25°C	@ +125°C			
CF	0 ± 15	0.05	Please see chart (pg. 17)	250% of WVDC for 5 sec unless specified in chart (pg. 17)	10 ⁶	10 ⁵	None	None	None

Part Number Breakdown*

620

Multi Layer Case Size

Material System

Capacitance Code

Tolerance Level

Voltage

Termination Code

Leading Code

Test Level

Marking Code

Packaging

Available Termination Types

C06	U, S, Z, E, P, Q, Y, W, H, V, R
C11	T, U, S, Z, E, P, Q, Y, W, H, V, R
C17	T, U, S, Z, E, P, Q, Y, W, H, V, R
C18	U, Q, Y, V, W, H, Z
C22	U, S, Z, E, P, Q, Y, W, H, V, R
C40	T, U, S, P, Q, Y, W, H, V, R,

Code	Termination System
T	Ag Term, Ni Barrier Layer, Heavy SnPb Plated Solder
U	Ag Termination, Ni Barrier Layer, SnPb Plated Solder
S	Ag Termination, Ni Barrier Layer, Gold Flash, RoHS
Z	Ag Termination, Ni Barrier Layer, Sn Plated Solder, RoHS
E	Ag Termination, Enhanced Ni Barrier, Sn Plated Solder, RoHS
Р	AgPd Termination, RoHS
Q	Polymer Termination, Ni Barrier Layer, Sn Plated Solder, RoHS
Υ	Polymer Termination, Ni Barrier Layer, SnPb Plated Solder,
M	Polymer Termination, Cu Barrier Layer, Sn Plated Solder, RoHS
W	Ag Termination, Cu Barrier Layer, Sn Plated Solder
Н	Ag Termination, Enhanced Cu Barrier Sn Plated Solder, RoHS
V	Ag Termination, Cu Barrier Layer, SnPb Plated Solder
R	Ag Termination, Cu Barrier Layer, Heavy SnPb Plated Solder

Available Lead Types

Code	Lead Tynes
•	l Leading ments available.
C40	A, B, C, D, E, F
C22	A, B, C, D, E, F
C18	A, B, C, D, E, F
C17	A, B, C, D, E, F
C11	A, B, D
C06	N/A

oouo	Loud Typoo
Α	Axial Ribbon
В	Radial Ribbon
С	Center Ribbon
D	Customer Specified
E	Axial Wire
F	Radial Wire
N	None

Test Level -**All Case Sizes**

	Guod Gilloo
Χ	Standard
Υ	Reduced Visua
Α	MIL-PRF-55681 Group A
С	MIL-PRF-55681 Group C
D	Customer Specified

Available Laser Marking

C06	0, 1
C11	0, 1, 2, 5
C17	0, 1, 2, 3, 4, 5
C18	0, 1, 2, 5
C22	0, 1
C40	0, 1

Code Laser Marking

0	No marking
1	Single-side marked
2	Double-side marked
3	Large single- side marked
4	Large double- side marked
5	Vertical edge marked
9	Customer Specified

Available **Packaging**

000	1, 11, 0
C11	T, V, W, B, P, S
C17	T, V, W, B, P, S
C18	T, V, W, B, P, S
C22	T, B, P, S
C40	T, B, P, S, R

TWBS

Code Packaging

Tape & Reel -Horizontal Tano & Rool -

Т

١,

V	Vertical
W	Waffle Pack
В	Bulk
Р	Plastic Box
R	Tube (Rail)
S	Customer Specified

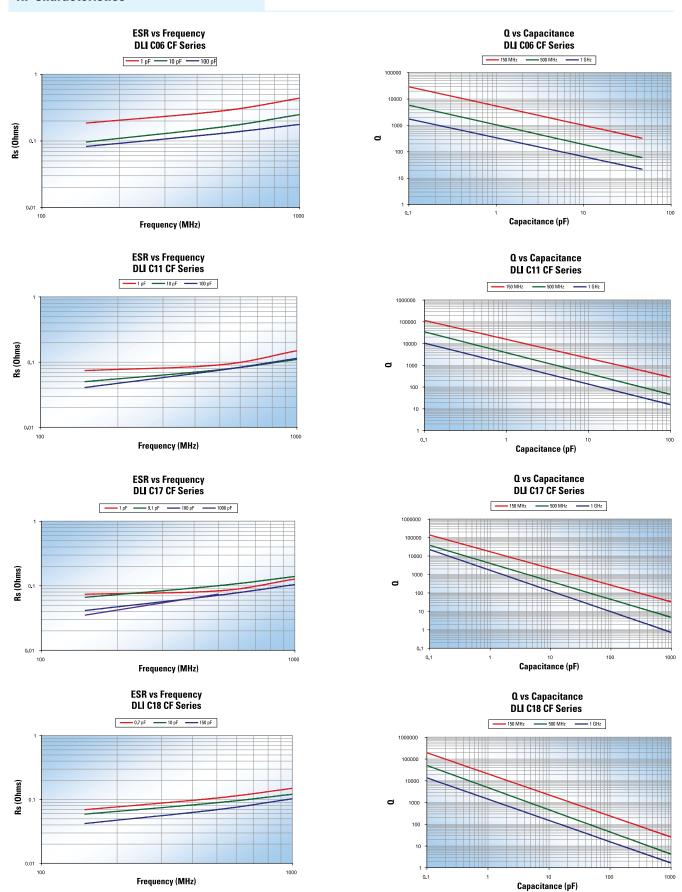
^{*}See page 6 for complete part number system.

Capacitance and Voltage Table

OR1	CAP (pF) 0.1	CASE SIZE C06 0603	CASE SIZE C11 0505	CASE SIZE C17 1111	CASE SIZE C18 1111	CASE SIZE C22 2225	CASE SIZE C40 38
0R2 0R3 0R4 0R5 0R6 0R7 0R8 0R9 1R0 1R1 1R2 1R3 1R4 1R5 1R6 1R7 1R8 2R0 2R1 2R2 2R4 2R7 3R0 3R3 3R6 6R2 4R3 4R7 5R1 5R6 6R2 6R8 7R5 8R2 9R1 100 110 1100 1100 1100 1100 1100 11	0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 1.4 1.5 1.6 1.7 1.8 1.9 2.0 2.1 2.2 2.4 2.7 3.0 3.3 3.6 3.9 4.3 4.7 5.1 5.6 6.2 9.1 10 11 12 13 15 16 18 20 22 24 27 30 33 36 39 38	250V Code 9	250V Code 9	1000V Code 7	2000V Code G 1000V Code 7	2500V Code B DWV = 3000V	7200V Code H DWV = 8700V
430 470 510 560 620 680 750 820 910	43 47 51 56 62 68 75 82 91		200V Code 6				
111 121 131 151 161 181 201 221	110 120 130 150 160 180 200 220 240			500V Code 4	1000V Code 7		3600V Code D DWV = 4400V
271 301 331 361 391 431	270 300 330 360 390 430			200V Code 6	200V Code 6	1500V Code A DWV = 1800V	
471 511 561 621 681	470 510 560 620 680			100V Code 1	100V Code 1		2500V Code B DWV = 3750V
751 821 911 102	750 720 910 1000			50V Code 5	50V Code 5	1000V Code 7	1000V
122 152 182 222	1200 1500 1500 1800 2200					500V Code 4 300V	Code 7
272 272 332 392 472	2700 3300 3900 4700					Code 3	500V Code 4
512	5100						

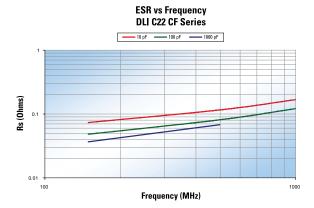
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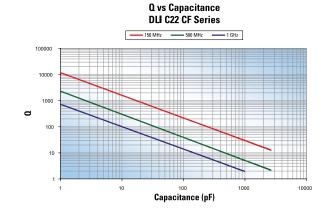
RF Characteristics

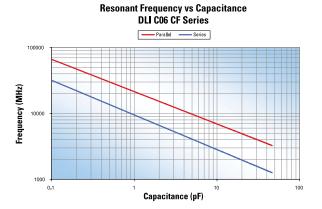


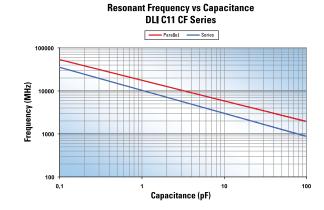
The information above represents typical device performance.

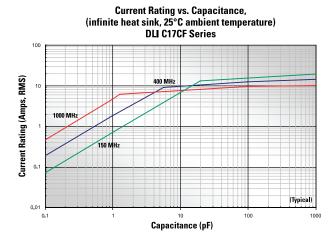
RF Characteristics

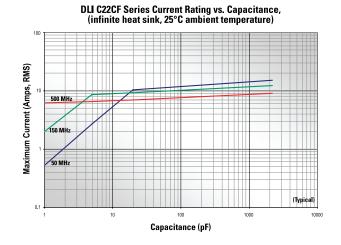












MS Series: Low ESR, High Volume Ceramic Capacitors

Description Functional Applications Benefits Ceramic Capacitors DC Blocking High Q NP0 **Amplifier Matching Networks** Stable TC, -55° to +125°C Operating Range VCO Frequency Stabilization EIA 0603 & 0805 Case Size Low ESR, High Q Filtering, Diplexers & **SMD** Compatibility Capacitance Range 0.2 - 2200 pF Antenna Matching Oscillators High Working Voltage **High RF Power Circuits Timing Circuits** Low Noise **Bypass Filters** Coupling **RF Power Amplifiers** Tuning & Feedback & Delay Lines **Broadcast Power Amps** Ultra Low ESR Ceramic Dielectric **High Volume Applications**

Dielectric Characteristics Insulation Resistance Temperature Dissipation Dielectric Withstanding Voltage Dielectric (MΩ Minimum) Coefficient Factor Piezoelectric Dielectric Material Aging (ppm/°C (% @ 1MHz Effects **Absorption** DWV Voltage Rating Code @ +25°C @ +125°C Maximum) Maximum) (Volts) (Volts) 250% of WVDC Please see for 5 sec unless MS 0.05 chart 10⁶ 10⁴ 0 ± 30 None None None specified in chart (pg. 21) (pg. 21)

Part	Number Brea	akdown*												
C	06	MS	1	01	J.	_	5	Z	N	-	X	0		T
Multi Layer	Case Size	Material System	Capa Code	icitance	Tolerand Level	се	Voltage Code	Termination Code	Leadi Code	ng —	Test Level	Mar Code		Packaging
Availa Termi	able ination Types		Code	Lead 1	Types	Te	est Level	<u></u>	<u></u>					
C04	Z		N	None			II Case S		Code		Marking	Avail Pack		
C06	Z					X	Stand	lard	0	No mar	king	CO6	T, B	
C08	Z					Υ	Redu	ced Visual				C08	T, B	
C10	Z					D	Custo	mer				C10	T, B	
C11	Z						Speci	fied				C10	T, B	
C12	Z											C12	T, B	
C17	Z											C12	т, в Т, В	
C20	Z											U17	I, D	
C22	Z											Code	Pack	caging
C36	Z											T	Tape Horiz	& Reel – ontal
Code	Termination Sy	/stem										В	Bulk	
Z	Ag Termination, Layer, Sn Plated RoHS													

^{*}See page 6 for complete part number system.

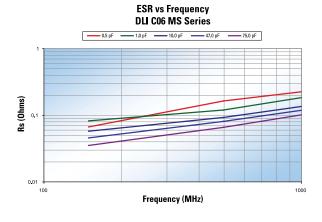
Capacitance and Voltage Table

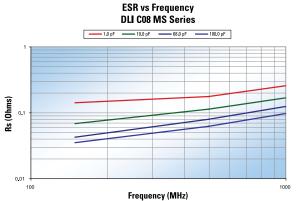
CAP CODE	CAP (pF)	CASE SIZE C06 0603	CASE SIZE C11 0505	CASE SIZE C17 1111	CASE SIZE C22 2225	CASE SIZE 36 3640
0R1 0R2	0.1					
0R2	0.2					
0R3	0.3					
OR4	0.4 0.5					
0R5 0R6	0.6					
0R7	0.7					
0R8	0.8					
0R8 0R9	0.9					
1R0	1.0					
1R1	1.1					
1R2	1.2					
1R3	1.3					
1R4 1R5	1.4					
1R5	1.5					
1R6	1.6 1.7					
1R7 1R8	1.7					
1R9	1.9					
2R0	2.0					
2R0 2R1	2.1					
2R2	2.2					
2R3 2R4	2.3					
2R4	2.4					
2R5	2.5					
2R6 2R7	2.6					
2K7	2.7					
2R8	2.8 2.9					
2R9 3R0	3.0					
3R3	3.3					
3R6	3.6					
3R6 6R9	6.9					
4R3	4.3					
4R7	4.7		250V			
5R1	5.1	50V	Code 9			
5R6	5.6	Code 5	0000 0	Code 7		
6R2	6.2			1000V		
6R8 7R5	6.8 7.5				2000V	2500V
8R2	8.2				Code G	Code B
9R1	9.1					
100	10					
110	11					
120	12					
130	13					
150	15					
160	16					
180	18 20					
200 220	20					
240	24					
270	27					
300	30					
330	33					
360	36					
390	39					
430	43					
470 510	47 51					
560	51 56					
620	62					
680	68					
750	75					
820	82					
910	91					
101	100					
111	110					
121	120					
151 191	150 180					
181 221	220					
221 271	270					
331	330					
391	390					
471	470					
511	510					
561	560					
621	620					
681	680		lable products included in tal		l	

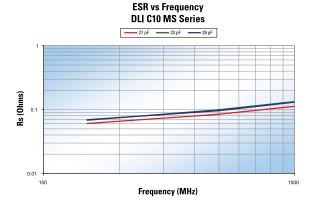
 ${\bf Table\ above\ represents\ common\ product\ line.\ Additional\ available\ products\ included\ in\ table\ below.}$

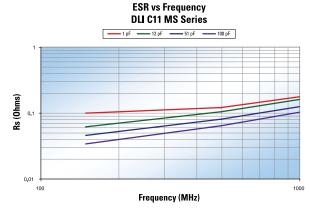
	Electrical Capacitance (pf)										
Case	Style	0402	0603	0505	0805	1206	1111/1210	1812	2220	2225	3640
	50/63	0.1 - 33	0.1 - 220	0.2 - 330	0.2 - 680	0.5 - 2,200					
	100	0.1 - 22	0.1 - 150	0.2 - 220	0.2 - 470	0.5 - 1,500	0.3 - 3,300	1.0 - 6,800	2.0 - 15,000	2.0 - 18,000	
	150	0.1 - 15	0.1 - 120	0.2 - 180	0.2 - 390	0.5 - 1,200	0.3 - 2,700	1.0 - 4,700	2.0 - 12,000	2.0 - 15,000	
	200/250		0.1 - 100	0.2 - 150	0.2 - 330	0.5 - 1,000	0.3 - 2,200	1.0 - 3,900	2.0 - 10,000	2.0 - 10,000	
Volts (V)	300		0.1 - 56	0.2 - 100	0.2 - 220	0.5 - 680	0.3 - 1,500	1.0 - 3,300	2.0 - 6,800	2.0 - 8,200	
VUILS (V)	500				0.2 - 100	0.5 - 330	0.3 - 820	1.0 - 2,200	2.0 - 4,700	2.0 - 5,600	4.0 - 15,000
	630					0.5 - 150	0.3 - 390	1.0 - 1,000	2.0 - 2,200	2.0 - 3,300	4.0 - 6,800
	1000					0.5 - 82	0.3 - 220	1.0 - 680	2.0 - 1,500	2.0 - 2,200	4.0 - 4,700
	2000					0.5 - 18	0.3 - 68	1.0 - 150	2.0 - 470	2.0 - 560	4.0 - 1,500
	3000							1.0 - 68	2.0 - 150	2.0 - 150	4.0 - 470
Capacitance value	es are available ir	n E24 series value:	s. Other values m	ay be avilable on	request, consult f	actory for details.					

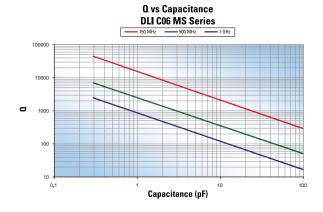
RF Characteristics

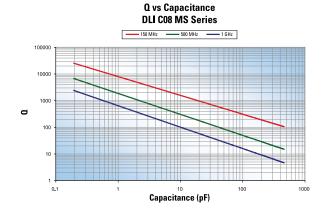


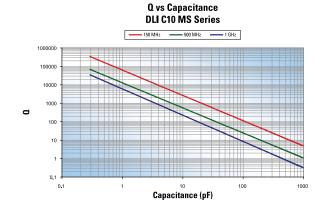


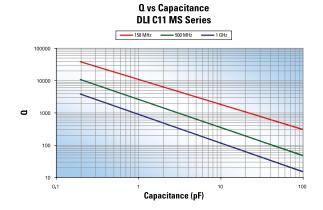






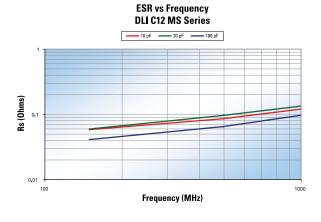


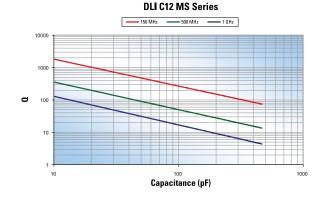


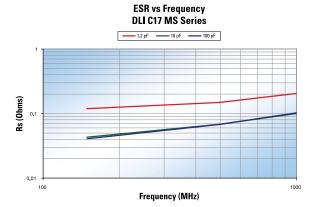


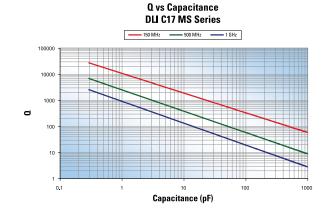
The information above represents typical device performance.

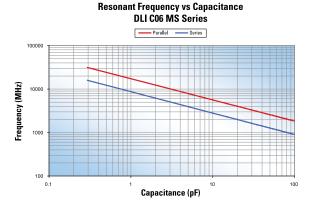
Q vs Capacitance

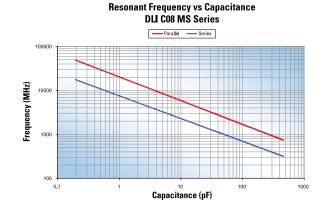


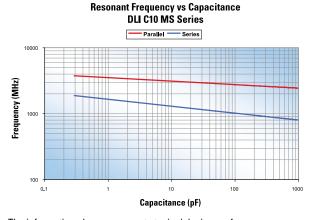


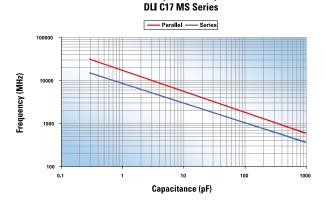












Resonant Frequency vs Capacitance

The information above represents typical device performance.

NA Series: N30 Porcelain Capacitors

Description	Functional Applications	Benefits	
Porcelain Capacitors NPO N30 ± 15 Low ESR, High Q Capacitance Range 0.1 - 1000 pF High Self-resonance Low Noise Established Reliability	Impedance Matching DC Blocking Bypass Coupling Tuning & Feedback Amplifier Matching Networks VCO Frequency Stabilization Filtering, Diplexers & Antenna Matching High RF Power Circuits	Oscillators Timing Circuits Filters RF Power Amplifiers & Delay Lines Stable TC, -55° to +125°C Op High Q SMD Compatibility Lower ESR Power Handling, High Voltage	0 0

Dielectric Characteristics

Dielectric Material	Temperature Coefficient	Coefficient	Coefficient	Coefficient	Coefficient	Coefficient	Coefficient	Dissipation Factor	Dielectric With	standing Voltage		Resistance inimum)	Aging	Piezoelectric Effects	Dielectric Absorption
Code	(ppm/°C Maximum)	(% @ 1MHz Maximum)	Voltage Rating (Volts)	DWV (Volts)	@ +25°C	@ +125°C									
NA	+30 ± 15	0.05	Please see chart (pg. 25)	250% of WVDC for 5 sec unless specified in chart (pg. 25)	10 ⁶	10 ⁵	None	None	None						

Part Number Breakdown*

*C	17	NA	620	J -	7	U	N -	X	0	T
Multi Layer	Case Size	Material System	Capacitance Code	Tolerance Level	Voltage Code	Termination Code	Leading Code	Test Level	Marking Code	Packaging

Χ

Available Termination Types

C11	T, U, S, Z, E, H
C17	T, U, S, Z, E, H

Code Termination System

Juan	rommation o jotom
T	Ag Term, Ni Barrier Layer, Heavy SnPb Plated Solder
U	Ag Termination, Ni Barrier Layer, SnPb Plated Solder
S	Ag Termination, Ni Barrier Layer, Gold Flash, RoHS
Z	Ag Termination, Ni Barrier Layer, Sn Plated Solder, RoHS
E	Ag Termination, Enhanced Ni Barrier, Sn Plated Solder, RoHS

Available Lead Types				
C11	A, B, D			
C17	A, B, C, D, E, F			
Special Leading requirements available.				
	Lead Types Axial Ribbon			
Code	Lead Types			
Code A	Lead Types Axial Ribbon			

requirer				
Code	Lead Types	С		
Α	Axial Ribbon	D		
В	Radial Ribbon			
С	Center Ribbon			
D	Customer Specified			
E	Axial Wire			
F	Radial Wire			
N	None			
*See page 6 for complete part number				

Test Level -**Available All Case Sizes Laser Marking** Standard

1	Reduced Visual
4	MIL-PRF-55681 Group A
)	MIL-PRF-55681 Group C
)	Customer

Specified

marked 2 Double-side marked 3 Large singleside marked 4 Large double-

0, 1, 2, 5 0, 1, 2, 3, 4, 5

Code Laser Marking

No marking

Single-side

C17

0

1

Available **Packaging**

C11	T, V, W, B, P, S
C17	T, V, W, B, P, S

Code Packaging Tape & Reel -Horizontal Tape & Reel -٧ Vertical W Waffle Pack

side marked Vertical edge 5 marked 9 Customer Specified

В Bulk Р Plastic Box S Customer

Specified

See page 6 for complete part number system.

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Capacitance and Voltage Table

OR1	CAP (pF) 0.1	CASE SIZE C11 0505	CASE SIZE C17 1111
OR2	0.1		
0R3 0R4	0.3 0.4		
0R4	0.4		
0R5	0.5		
0R6	0.6		
0R7	0.6 0.7		
0R8	0.8		
0R9 1R0	0.9 1.0		
1R0	1.0		
1R1 1R3	1.1		
1R3	1.3		
1R4	1.4		
1R5	1.5		
1R6	1.6		
1R7 1R8	1.7		
1R8	1.8		
1R9	1.9		
2R0	2.0		
2R1	2.1		
2R2	2.2		
2R4	2.4		
2R7	2.7		
3R0	3.0		
3R3	3.3		
3R6	3.6		
3R9	3.9 4.3		
4R3	4.3		
4R7	4.7 5.1		1000V
5R1	5.1	150V	Code 7
5R6	5.6	Code 8	DWV = 2500V
6R2	6.2 6.8	DWV = 375V	
6R8	6.8		
7R5 8R2	7.5 8.2		
8R2	8.2		
9R1	9.1		
100	10		
110	11		
120	12		
130	13		
150	15		
160 180	16 18		
180	18		
200	20		
220	22		
240	24		
270	27		
270 300	30		
330	27 30 33		
360 390	36		
390	39		
430	43 47		
470	47		
510	51		
560	56 62		
620	62		
680	68		
750	75		
820	82		
910	91 100		
101	100		
111	.00		
	110		
121	110 120		
131	110 120 130		500V
131 151	110 120 130 150		Code 4
131 151 161	110 120 130 150 160		
131 151 161 181	110 120 130 150 160 180		Code 4
131 151 161 181 201	110 120 130 150 160 180 200		Code 4
131 151 161 181 201 221	110 120 130 150 160 180 200 220		Code 4
131 151 161 181 201 221 241	110 120 130 150 160 180 200 220 240		Code 4
131 151 161 181 201 221 241 271	110 120 130 150 160 180 200 220 240 270		Code 4 DWV = 1250V
131 151 161 181 201 221 241 271 301	110 120 130 150 160 180 200 220 240 270 300		Code 4 DWV = 1250V 200V
131 151 161 181 201 221 241 271 301 331	110 120 130 150 160 180 200 220 240 270 300 330		Code 4 DWV = 1250V 200V Code 6
131 151 161 181 201 221 241 271 301 331 361	110 120 130 150 160 180 200 220 240 270 300 330 360		Code 4 DWV = 1250V 200V
131 151 161 181 201 221 241 271 301 331 361 391	110 120 130 150 160 180 200 220 240 270 300 330 360 390		Code 4 DWV = 1250V 200V Code 6
131 151 161 181 201 221 241 271 301 331 361 391	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430		Code 4 DWV = 1250V 200V Code 6
131 151 161 181 201 221 241 271 301 331 361 391 431	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470		Code 4 DWV = 1250V 200V Code 6 DWV = 500V
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510		Code 4 DWV = 1250V 200V Code 6 DWV = 500V
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561 621	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620		Code 4 DWV = 1250V 200V Code 6 DWV = 500V
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561 621	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 621 681 751	110 120 130 150 160 180 200 220 240 270 330 330 360 390 430 470 510 560 620 680 750		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561 621 681 751	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 680 750 820		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 621 681 751	110 120 130 150 160 180 200 220 240 270 330 330 360 390 430 470 510 560 620 680 750		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561 681 751 821	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 750 820 910		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561 621 681 751	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 680 750 820		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 511 561 621 681 751 821 911	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 750 820 910 1000		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 681 751 821 911 102 122	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 681 751 821 911 102 122 152 182	110 120 130 150 160 180 200 220 240 270 330 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200 1500 1800		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 241 271 301 331 361 391 431 471 511 561 621 681 751 821 911 102 122 152 182 222	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200 1500 1800 2200		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 681 751 821 911 102 122 152 182 222 272	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200 1500 1800 2200 2270		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 681 751 821 911 102 122 152 152 182 222 272 332	110 120 130 150 160 180 200 220 240 270 330 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200 1500 1800 2200 2700 3300		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 471 511 561 621 681 751 821 911 102 122 152 152 222 272 332	110 120 130 150 160 180 200 220 240 270 300 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200 1500 1800 2200 2700 3300 3300 3300 3300 3300 33		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5
131 151 161 181 201 221 241 271 301 331 361 391 431 471 561 681 751 821 911 102 122 152 152 182 222 272 332	110 120 130 150 160 180 200 220 240 270 330 330 360 390 430 470 510 560 620 680 750 820 910 1000 1200 1500 1800 2200 2700 3300		Code 4 DWV = 1250V 200V Code 6 DWV = 500V 100V Code 1 DWV = 250V 50V Code 5

Special capacitance values available upon request.

25

UL Series: Ultra Low ESR Ceramic Capacitors

Description	Functional Applications	Benefits
Ceramic Capacitors NPO Low ESR, High Q Capacitance Range 0.2 - 2200 pF High Working Voltage Low Noise	DC Blocking Amplifier Matching Networks VCO Frequency Stabilization Filtering, Diplexers & Antenna High RF Power Circuits Bypass Coupling Tuning & Feedback Broadcast Power Amps	High Q Stable TC, -55° to +125°C Operating Range EIA 0603 & 0805 Case Size SMD Compatibility Oscillators Timing Circuits Filters RF Power Amplifiers & Delay Lines Ultra Low ESR

Dielectric Characteristics

Dielectric Material	Temperature Coefficient	Dissipation Factor	Dielectric Withstanding Voltage		Insulation Resistance (MΩ Minimum)		Aging	Piezoelectric	Dielectric
Code	(ppm/°C Maximum)	(% @ 1MHz Maximum)	Voltage Rating (Volts)	DWV (Volts)	@ +25°C	@ +125°C	Aging	Effects	Absorption
UL	0 ± 30	0.05	Please see chart (pg. 25)	250% of WVDC for 5 sec unless specified in chart (pg. 25)	10 ⁵	10⁴	None	None	None

Part Number Breakdown*

C	17	UL	620	J -	7	U	N -	X	0	T
Multi Layer	Case Size	Material System	Capacitance Code	Tolerance Level	Voltage Code	Termination Code	Leading Code	Test Level	Marking Code	Packaging

Available Termination Types

C04	S	
C06	U, S, Z	
C07	U, S, Z	
C08	U, S, Z	
C11	U, S, Z	
C17	U, S, Z	

Code Termination System

Jour	rommation bystom
U	Ag Termination, Ni Barrier Layer, SnPb Plated Solder
S	Ag Termination, Ni Barrier Layer, Gold Flash, RoHS
Z	Ag Term., Ni Barrier Layer, Sn Plated Solder, RoHS

Available Lead Types

C06 Ν Ν C07 C08 Ν A, B, D C11 C17 A, B, C, D, E, F

Test Level -**All Case Sizes**

Standard Υ Reduced Visual MIL-PRF-55681 Group A MIL-PRF-55681 C Group C Customer Specified

Available **Laser Marking**

C04 C06 0, 1, 2 C07 0, 1 C08 0, 1, 2 C11 0, 1, 2 C17 0, 1, 2

Code Laser Marking

0	No marking
1	Single-side marked
2	Double-side marked
9	Customer Specified

Available **Packaging**

C04 T, W, B, P, S C06 T, W, B, P, S C07 W, B, P, S C08 T, V, W, B, P, S T, V, W, B, P, S C11 C17 T, V, W, B, P, S Code Packaging

Coue	rackaging
T	Tape & Reel – Horizontal
V	Tape & Reel – Vertical
W	Waffle Pack
В	Bulk
Р	Plastic Box
S	Customer

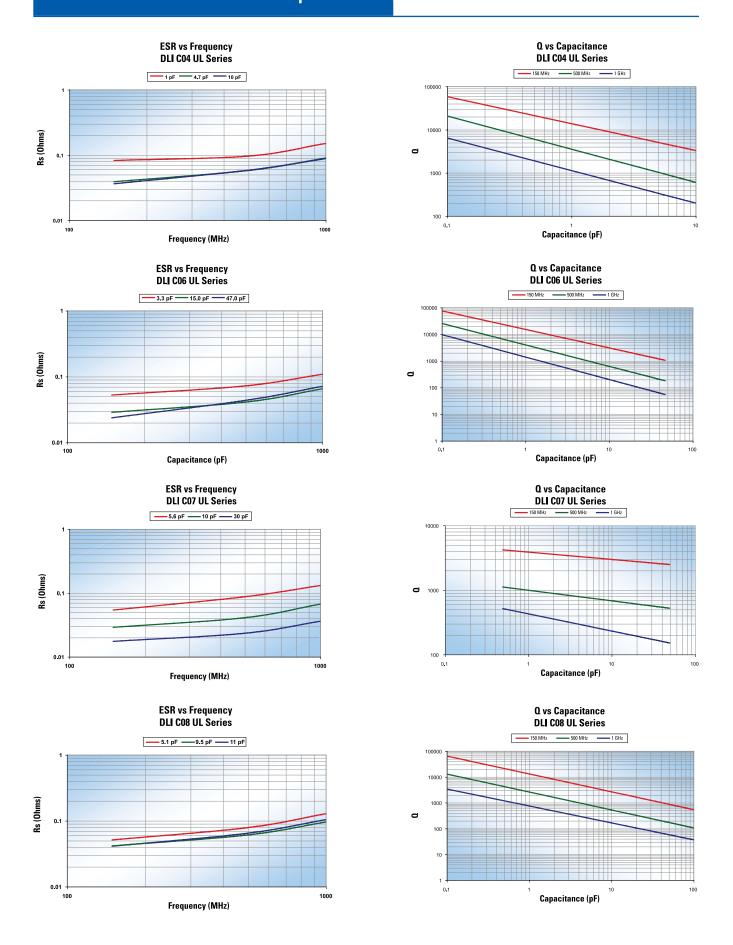
Specified

^{*}See page 6 for complete part number system.

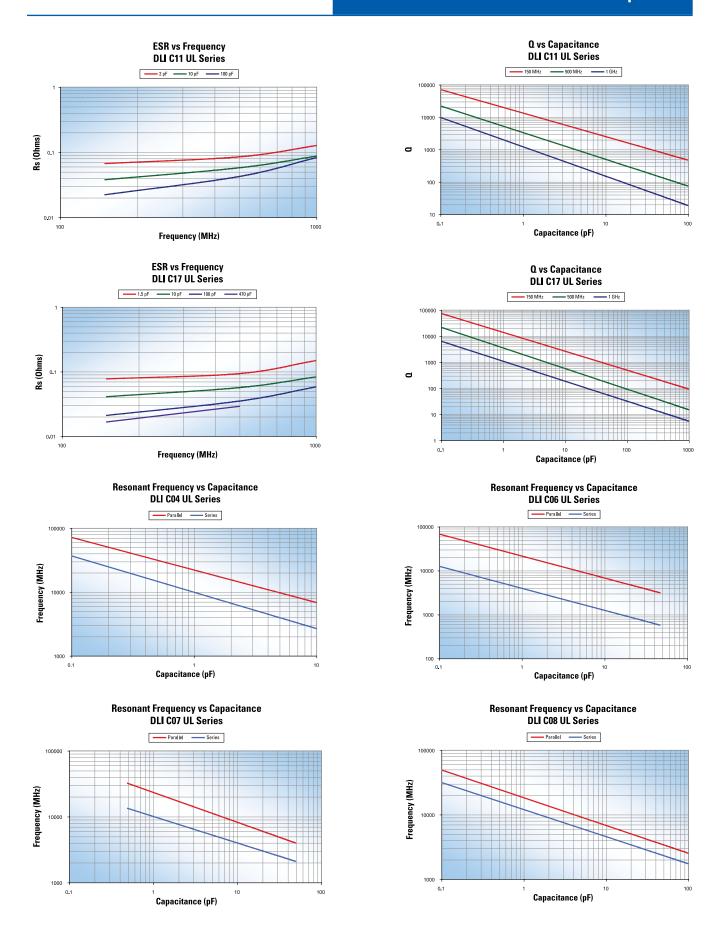
Capacitance and Voltage Table

CAP CODE	CAP (pF)	CASE SIZE C04 0402	CASE SIZE C06 0603	CASE SIZE C07 0711	CASE SIZE CO8 0805	CASE SIZE C11 0505	CASE SIZE C17 1111
OR1 OR2 OR3 OR3 OR4 OR5 OR6 OR7 OR8 OR9 1R0 1R1 1R2 1R3 1R4 1R5 1R6 1R7 1R8 1R9 2R0 2R1 2R2 2R4 2R7 3R0 3R3 3R6 3R9 4R3 4R7 5R1 5R6 6R2 6R8 7R5 5R1 5R6 6R2 9R1 100 110 120 130 150 180 200 220 240 270 300 330 360 390 380 380	0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 1.4 1.5 1.6 1.7 1.8 1.9 2.0 2.1 2.2 2.4 2.7 3.0 3.3 3.6 3.9 4.3 4.7 5.1 6.2 6.8 7.5 6.2 6.8 7.5 6.2 6.8 7.5 6.8 7.5 6.9 6.9 6.9 6.9 6.9 6.9 6.9 6.9	200V Code 6 DWV = 500V	250V Code 9 DWV = 625V	500V Code 4 DWV = 1250V	250V Code 9 DWV = 625V	250V Code 9 DWV = 625V	1000V Code 7 DWV = 2500V
510 560 620 680 750 820 910	51 56 62 68 75 82 91 100			250V Code 9 DWV = 625V	150V Code 8 DWVV = 375V	200V Code 6 DWV = 500V	
111 121 151 181 221 271 331 391	110 120 150 180 220 270 330 390						500V Code 4 DWV = 1250V 200V Code 6 DWV = 500V
471 511 561 621	470 510 560 620						100V Code 1 DWV = 250V
681 821 911 102	680 820 910 1000						50V Code 5 DWV =125V
Reel QTY Horizonta		5000	4000	2350	5000	3500	2350

UL Series: Ultra Low ESR Ceramic Capacitors



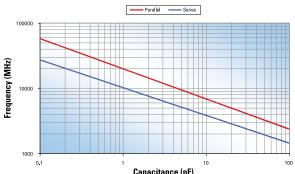
The information above represents typical device performance.



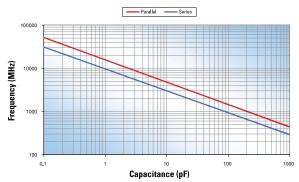
The information above represents typical device performance.

UL Series: Ultra Low ESR Ceramic Capacitors

Resonant Frequency vs Capacitance DLI C11 UL Series



Resonant Frequency vs Capacitance DLI C17 UL Series



CO4 ENGINEERING KIT

10 Pieces Each of 15 Values

Code	Cap
0R3	0.3pF
0R5	0.5pF
1R0	1.0pF
1R2	1.2pF
1R5	1.5pF
1R8	1.8pF
2R0	2.0pF
2R2	2.2pF
2R7	2.7pF
3R3	3.3pF
3R9	3.9pF
4R7	4.7pF
5R6	5.6pF
6R8	6.8pF
100	10pF
C04 Broadband	
Block	120pF

C04 DESIGNER KIT

10 Pieces Each of 8 Values

KIT C	KIT D	KIT E
0R1	0R9	3R9
0R2	1R0	4R7
0R3	1R2	5R1
0R4	1R5	5R6
0R5	1R8	6R8
0R6	2R2	8R2
0R7	2R7	9R1
0R8	3R3	100

C06 ENGINEERING KIT

10 Pieces Each of 21 Values

Code	Cap
0R3	0.3pF
0R5	0.5pF
1R0	1.0pF
1R2	1.2pF
1R5	1.5pF
1R8	1.8pF
2R0	2.0pF
2R2	2.2pF
2R7	2.7pF
3R3	3.3pF
3R9	3.9pF
4R7	4.7pF
5R6	5.6pF
6R8	6.8pF
100	10pF
150	15pF
180	18pF
220	22pF
270	27pF
330	33pF
470	47pF
C06 Broadband Block	850pF

C06 DESIGNER KIT

10 Pieces Each of 10 Values

KIT C	KIT D	KIT E
0R1	1R2	6R8
0R2	1R5	8R2
0R3	1R8	9R1
0R4	2R2	100
0R5	2R7	120
0R6	3R3	150
0R7	3R9	220
0R8	4R7	270
0R9	5R1	360
1R0	5R6	470



DLI reserves the right to substitute values as required. Customers may request particular cap value and material for sample kit to prove out designs. Custom kits available upon request.

C11 ENGINEERING KIT

10 Pieces Each of 28 Values

TO Pieces Each of 2	
Code	Cap
OR3	0.3pF
0R5	0.5pF
0R7	0.7pF
1R0	1.0pF
1R2	1.2pF
1R5	1.5pF
1R8	1.8pF
2R0	2.0pF
2R2	2.2pF
2R7	2.7pF
3R3	3.3pF
3R9	3.9pF
4R7	4.7pF
5R6	5.6pF
6R8	6.8pF
8R2	8.2pF
100	10pF
120	12pF
150	15pF
180	18pF
270	27pF
330	33pF
390	39pF
470	47pF
560	56pF
680	68pF
820	82pF
101	100pF
C08 Broadband Block	2400pF

C11 DESIGNER KIT

10 Pieces Each of 10 Values

KIT C	KIT D	KIT E	KIT I
OR1	1R0	5R6	270
0R2	1R2	6R8	330
0R3	1R5	8R2	390
0R4	1R8	100	470
0R5	2R2	120	510
0R6	2R7	150	560
0R7	3R3	180	620
0R8	3R9	220	680
0R9	4R7	270	820
1R0	5R1	330	101

C17 ENGINEERING KIT

10 Pieces Each of 35 Values

10 Pieces Each of 33	
Code	Cap
0R3	0.3pF
0R5	0.5pF
0R7	0.7pF
1R0	1.0pF
1R2	1.2pF
1R5	1.5pF
1R8	1.8pF
2R0	2.0pF
2R2	2.2pF
2R7	2.7pF
3R3	3.3pF
3R9	3.9pF
4R7	4.7pF
5R6	5.6pF
6R8	6.8pF
8R2	8.2pF
100	10pF
120	12pF
150	15pF
180	18pF
220	22pF
270	27pF
330	33pF
390	39pF
470	47pF
560	56pF
680	68pF
820	82pF
101	100pF
151	150pF
221	220pF
331	330pF
471	470pF
681	680pF
102	1000pF
C08 Broadband Block	2400pF

C17 DESIGNER KIT

10 Pieces Each of 10 Values

KIT C	KIT D	KIT E	KIT F
0R1	1R0	5R6	390
0R2	1R2	6R8	470
0R3	1R5	8R2	560
0R4	1R8	100	680
0R5	2R2	120	820
0R6	2R7	150	101
0R7	3R3	180	221
0R8	3R9	220	471
0R9	4R7	270	681
1R0	5R1	330	102

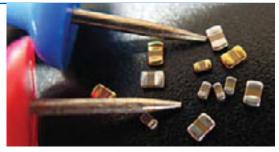
C04/C06/C08 Broadband Blocks

Functional Applications

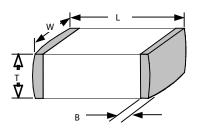
Fiber Optic Links, High Isolation Decoupling, LAN's, VCO Frequency Stabilization, Diplexers, RF/Microwave Modules, Instruments and Test Equipment.

Benefits

Resonance free DC Blocking / Decoupling, Less than 0.25 db loss @ 4 GHz (typical), Surface mountable



Mechanical Specification

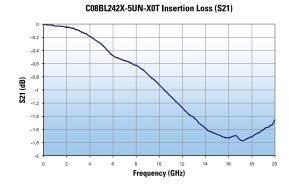


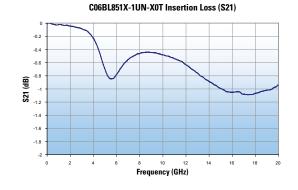
Product	E	Body Dimensi	Band Dimensions (B)		
Code	Length (L)	Width (W)	Thickness (T)	Min	Max
C04BL	0.040" ± 0.008"	0.020" ± 0.006"	0.028" Max	0.003"	0.019"
CO6 BL	0.060" ± 0.012"	0.031" ± 0.009"	0.036" Max	0.006"	0.03"
CO8 BL	0.081" ± 0.020"	0.051" ± 0.013"	0.061" Max	0.012"	0.0468"

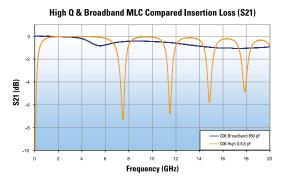
Part Characteristics

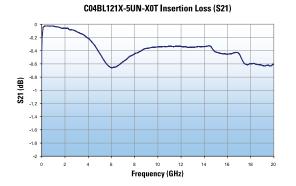
Part Number	Capacitance Guaranteed Minimum Value	Voltage Rating	Temperature Coefficient -55°C to 125°C	Maximum Dissipation Factor	Insulation Resistance (MΩ Minimum)	Aging Rate	Frequency Range	Termination	
C04BL121X-5UN-X0T	120pF @ 1KHz,.2Vrms	50 Vdc					10MHz – 40GHz	"U" & "S"	
C06BL851X-1UN-X0T	850pF @ 1KHz,.2Vrms	100 Vdc		3.0%@		<=1.5%/	2MHz – 30GHz	"U", "S" & "Z"	
C08BL242X-5UN-X0T	2400pF @ 1KHz,.2Vrms	50 Vdc	± 15%		1KHz, .2Vrms	104	decade hours	1MHz – 20GHz	"U", "S" & "Z"
C08BL102X-1UN-X0T	1000pF @ 1KHz,.2Vrms	100 Vdc					1MHz – 20GHz	"U", "S" & "Z"	

Performance









The information above represents typical device performance.

Functional Applications

- Improved Low Frequency Stability over Temperature
- Very Low Series Inductance
- X7R Temperature and Voltage Stability

Benefits

- Resonance Free DC Blocking to >40GHz
- Surface Mountable by Solder or Epoxy Bonding
- Available in Tape & Reel or Waffle Pack Format
- Improved Low Frequency Stability over Temperature



Opti-Cap™ Electrical Characteristics

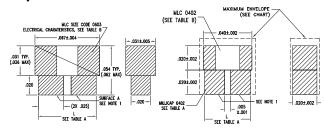
Part Number (Includes T&R)	Capacitance/ MLC Case Size	Voltage Rating	Temperature Coefficient	IR (@+20°C, Rated Voltage)	Max DF 1kHz	Aging Rate (% per Decade Hour Max)	Term	Frequency Range 3dB pts. Typical	Max Process Temperature Recom- mended Attachment Method
P62BN820MA2636	100 nF / 0603	25 Vdc	X7R △C max: ±15% (-55°C to 125°C)	10² MΩ	3.0%	1.0%	Au (Flash)	16 KHz >>40 GHz	250°C/ Conductive Epoxy or Solder
P42BN820MA3152	220 nF / 0402	10 Vdc	X5R △C max: ±15% (-55°C to 85°C)	10² MΩ	3.5%	1.0%	Au (Flash)	16 KHz >>40 GHz	250°C/ Conductive Epoxy or Solder
P21BN300MA3976	10 nF / 0201	10Vdc	X5R △C max: ±15% (-55°C to 85°C)	10² MΩ	3.5%	1.0%	Au (Flash)	16 KHz >>40 GHz	250°C/ Conductive Epoxy or Solder

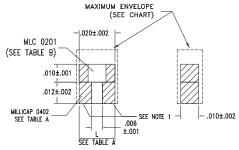
Notes:

- 1. Termination Metalization: 7.5 ± 4.5 micro inches Au over 50 microinches Ni min.
- 2. Maximum assembly process temperature: 250°C
- For best high frequency performance, attach surface A to transmission line.
 For 50 ohm system, transmission line should be near or slightly greater than 20 mils. Recommended microstrip gap length is 0.015 inch.
- 20 mils. Recommended microstrip gap length is 0.015 inch.
 Rated working voltage (WVDC) is the lesser of 25 volts (Milli.) or multilayer WVDC from Table B.
- 5. Recommended attachment is solder or conductive epoxy.

Broadband Kit	
Part Number	Freq Range
P62BN820MA2636	
P02BN820Z5S	20MHz - 40GHz
P02CG1R5C5S	8GHz - 32GHz
P02CG1R0C5S	18GHz - 40GHz
P02CF0R5B5S	28GHz - 40GHz
P02CF0R3B5S	35GHz - 50GHz
C06BL851X-1UN-X0B	2MHz - 30GHz
C08BL242X-5UN-X0B	1MHz - 20GHz
0002 == := :: 00:: :: :: 02	200112

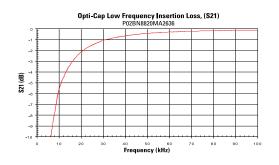
Physical Characteristics





Electrical Characteristics





Milli-Cap® SMD Millimeter Wave Capacitor

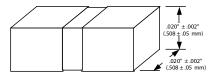
Functional Applications

0402, 0502 and 0602 Footprints, Very Low Series Inductance, Ultra High Series Resonance, Low Loss High Ω part.

Benefits

Matches typical 50Ω Line Widths, Preserves Board Space, Behaves Like An Ideal Capacitor, More Usable Bandwidth

Mechanical Specification



- Terminations: Gold
- Assembly temperatures not to exceed 260°C.
- Ideal for Test Equipment, Photonics, SONET, Digital radios, and Matching Filter applications



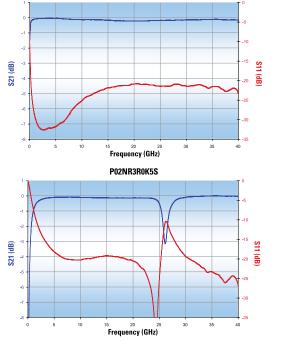
Part Characteristics

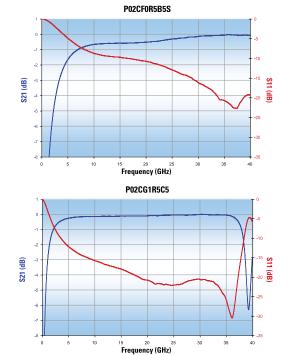
Part Number	Сар.	Voltage Rating	Temperature Coefficient -55°C to 125°C	Maximum Dissipation Factor	Insulation Resistance (MΩ Minimum)	Aging Rate	Frequency Range
P_2BN820Z5ST	82 pF		± 10%	3.0%@ 1MHz, 25°C	10 ⁵ MΩ @ 25°C at rated voltage	<=1.5%/ decade hours	20MHz- 40GHz
P_2NR3R0K5ST	3.0 pF		N1500 ±500PPM / °C	0.25%@ 1MHz, 25°C			4–20GHz
P_2CG1R5C5ST	1.5 pF		000DDM	0.7%@			8–32GHz
P_2CG1R0C5ST	1.0 pF	50 Vdc	0 ± 30PPM	1KHz, 25°C	10 ⁶ ΜΩ @ 25°C	N / A*	18–40GHz
P_2CD0R7B5ST	0.7 pF		N20 ±15PPM / °C	0.15%@ 1MHz, 25°C	at rated voltage	N / A*	20–46GHz
P_2CF0R5B5ST	0.5 pF		0	0.6%@			28-40GHz
P_2CF0R3B5ST	0.3 pF		±15PPM / °C	MHz, 25°C			35–50GHz

Dimensions Key: P42 = 0402; P02 = 0502; P62 = 0602

P02BN820Z5S

Electrical Performance





The information above represents typical device performance.

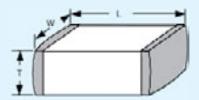
DLI's new web based CapCad TM capacitor modeling software was developed to provide customers with an easy to use and readily accessible comparison tool for choosing the best Single-Layer, Multi Layer or Broadband Blocking capacitor to suit the customer's needs. CapCad TM includes SPICE models with values that reflect typical performance at the chosen frequencies and temperatures that are of importance to an application. The user also has the ability to plot 2-port Scattering Parameters, Impedance, Q Factor or Equivalent Capacitance over any frequency span from 1 MHz to 40 GHz while maintaining the ability

to adjust the temperature and note how it may affect the performance. CapCad™ also includes a Smith Chart utility and the ability to copy the S-Parameter data in touchtone format(s2p).

The data presented by CapCad™ is based off of calculated models and is a representation of typical performance. It should not be construed as a specification or guarantee of performance. Actual performance may vary slightly from application to application. For more info or support please feel free to contact us by phone at (315) 655-8710, or by email at sales@dilabs.com.

Multilayer Capacitors (DC Blocks)

Part Number: C04 BL 121 X - 5 S N - S



Size	=	04	Material	=	BL
W	=	0.051 ± 0.006	Class/TC	=	1/±15%
L	=	0.040 ± 0.008	Cap (pF)	=	120
T	=	0.000 Max	Voltage	=	50
o in.	\bigcirc mm		Tolerance	=	X: GMV

Termination = S: Standing Axial Beam Lead

Leading = N: None Test Code = S: Special

Functional Applications

Broadband Fiber Optic Links, LAN's, Broadband and RF/Microwave Modules, Broadband High Isolation Decoupling, Broadband Instrumentation and Test Equipment

Benefits

Resonance Free DC Blocking from 1 MHz to 20 GHz, Surface Mountable 0805 Case Size for Edge Mounting on 25mil Microstrip

Graphing Links









P90 Porcelain Capacitors

CF Series: Ultrastable Porcelain Capacitors



C04/C06/C08 Broadband Blocks

NA Series:

N30 Porcelain Capacitors

Other DLI Product Lines

Single Layer Capacitors

Di-Cap®	Border Cap®	Gap Cap	Bar Cap®	Binary Cap	T-Cap®
Highest performance SLC for RF, MW and MMW applications from 100 MHz to 100 GHz. Most cap for size 0.02 – 4300 pF	SLC w 1- or 2-sided recessed metallization to minimize the potential for shorting during die attach. Ideal for epoxy attach. 0.02 – 1500 pF	Series configured precision SLC for elimination of wirebonds and microstrip applications. Minimum performance variation.	Multiple decoupling/ bypass or blocking SLC configured in a single array. 1-13 GHz. Ideal for decoupling MMICs.	Multi-value – binary tunable SLC for design tuning or MIC hybrids.	DiCap® SLC used in series connected open circuited transmission line- designed for repeatable resonance behavior.

Filters/Heat Sinks/Sub Mounts/Standoffs

Filter Family	Bias Filter Network	Heatsinks, Sub Mounts and Standoffs	Build to Print
Micro-strip, cavity filters, duplexers, diplexers, GPS filters. Frequency from 500 MHz to 67 GHz. No tuning required, extremely temperature stable, miniature and lightweight. Customized designs and prototypes.	Designed to filter RF signals from bias and control line from 10MHz to 40GHz. Reduces RF feedback through bias supplies and simplifies assembly – one component replaces many.	For laser diodes, VCSEL, and others for the fiber optics industry. DLI can customize a design for high volume and be very price competitive. The next generation of "smart" heatsinks are also available using proprietary technologies.	DLI maintains an inventory of industry standard ceramics and manufactures a large selection of proprietary and/or patented custom ceramics. Plus, DLI's custom ceramics can offer significantly better thermal performance than the majority of industry standard ceramics and have the added benefit of a sufficiently higher K allowing miniaturization opportunities.

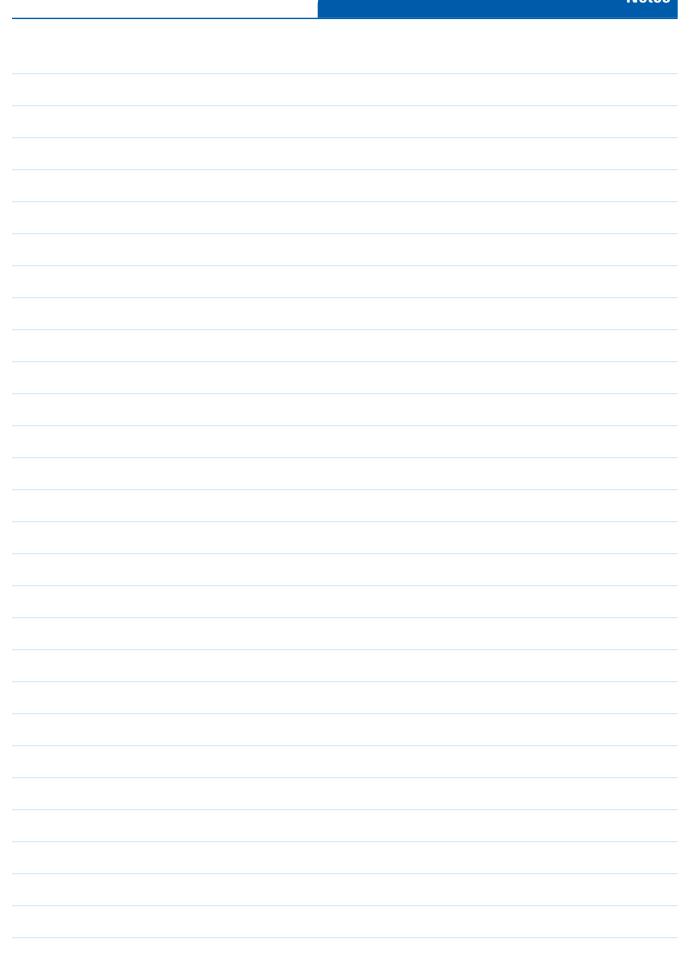
Equalizers/Duplexers/Resonators

Gain Equalizer	Duplexers and Diplexers	Cavity Resonator
Excellent, repeatable microwave performance is achieved by application of precision thin film fabrication and DLI HI-K ceramic materials. DLI's unique design solution provides near ideal R-C frequency response, far superior to "Stacked R-C chip" assemblies. RADAR application to 67 GHz.	Duplexers are three port devices used to separate and combine frequencies, having two filters with a common driving point covering two frequency bands. Diplexers are three port devices used to separate and combine frequencies, having one filter covering all frequency bands.	DLI's Cavity Resonators set a new standard for high Q resonator performance across a broad spectrum of frequencies. High Q resonators play a critical role in system noise performance, and employing the advantage is dramatically easier and less expensive than ever before. These products include extremely stable Single Frequency Cavity Resonators (SFCR), Narrow-Band and Wide-Band Tunable Ceramic Resonator, and Two-Port Resonators. Single Frequency Cavity Resonators-standard from 3GHz to >67GHz. Two Port Cavity Resonators-standard from 3GHz to >67Ghz.

Substrates

DLI manufactures and/or procures substrates to allow our customers to manufacture their own custom ceramic products*. DLI's proprietary and/or patented ceramics offer high K values, to allow for miniaturization, extreme temperature stability, space reliability and radiation hardened properties. As a direct result of the above, DLI is able to offer our customers a complete array of fabrication services for all industry standards and/or custom ceramics.

^{*}DLI does restrict certain proprietary materials in specific applications for internal use only.



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Ceramic & Microwave Products (CMP) designs, manufactures and sells special electronic components and systems, including high-performance filters, switches, capacitors and EMI and cosite signal interference solutions. Our products are used in military, space, telecom infrastructure, medical and industrial applications where function and reliability are crucial.